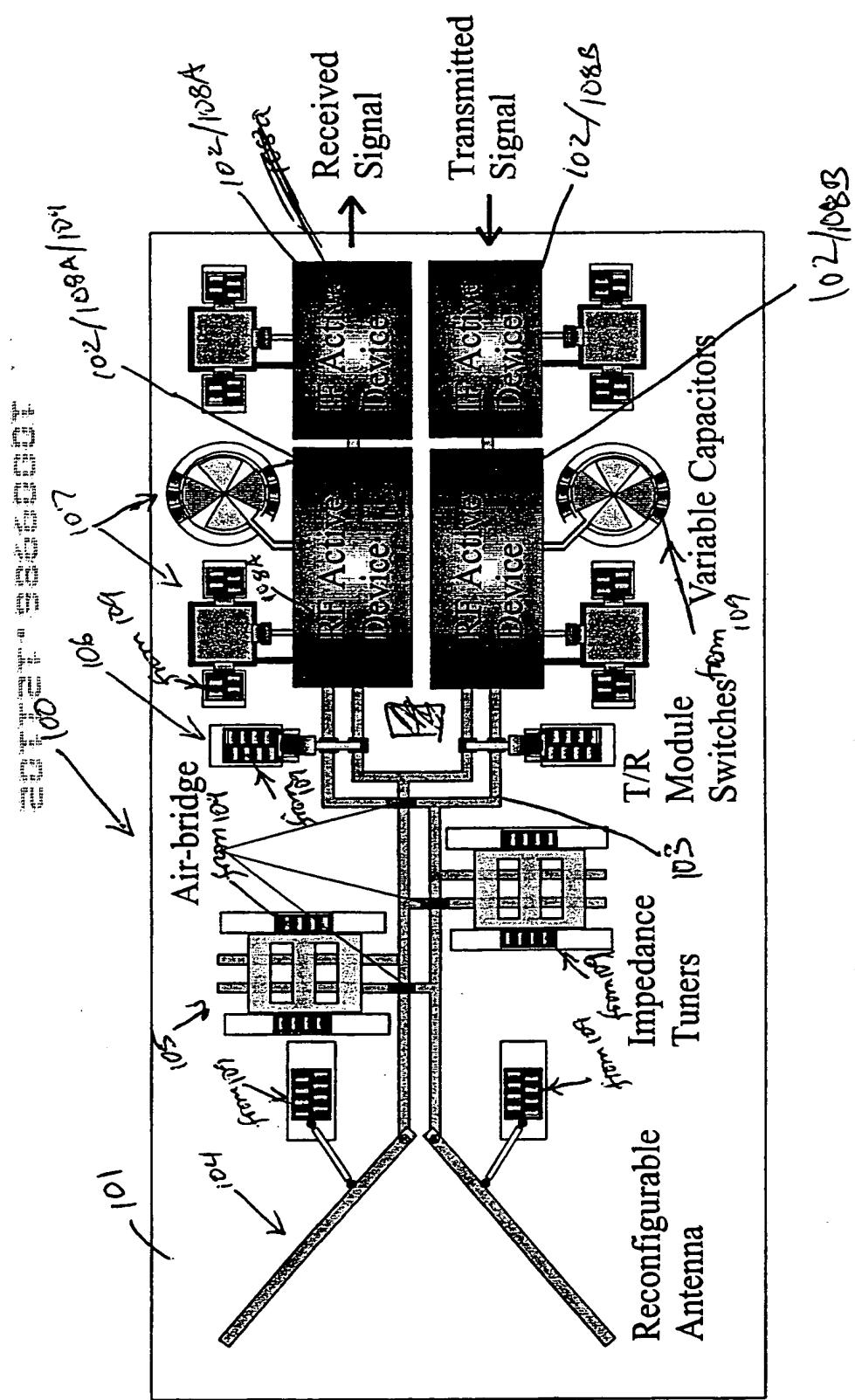


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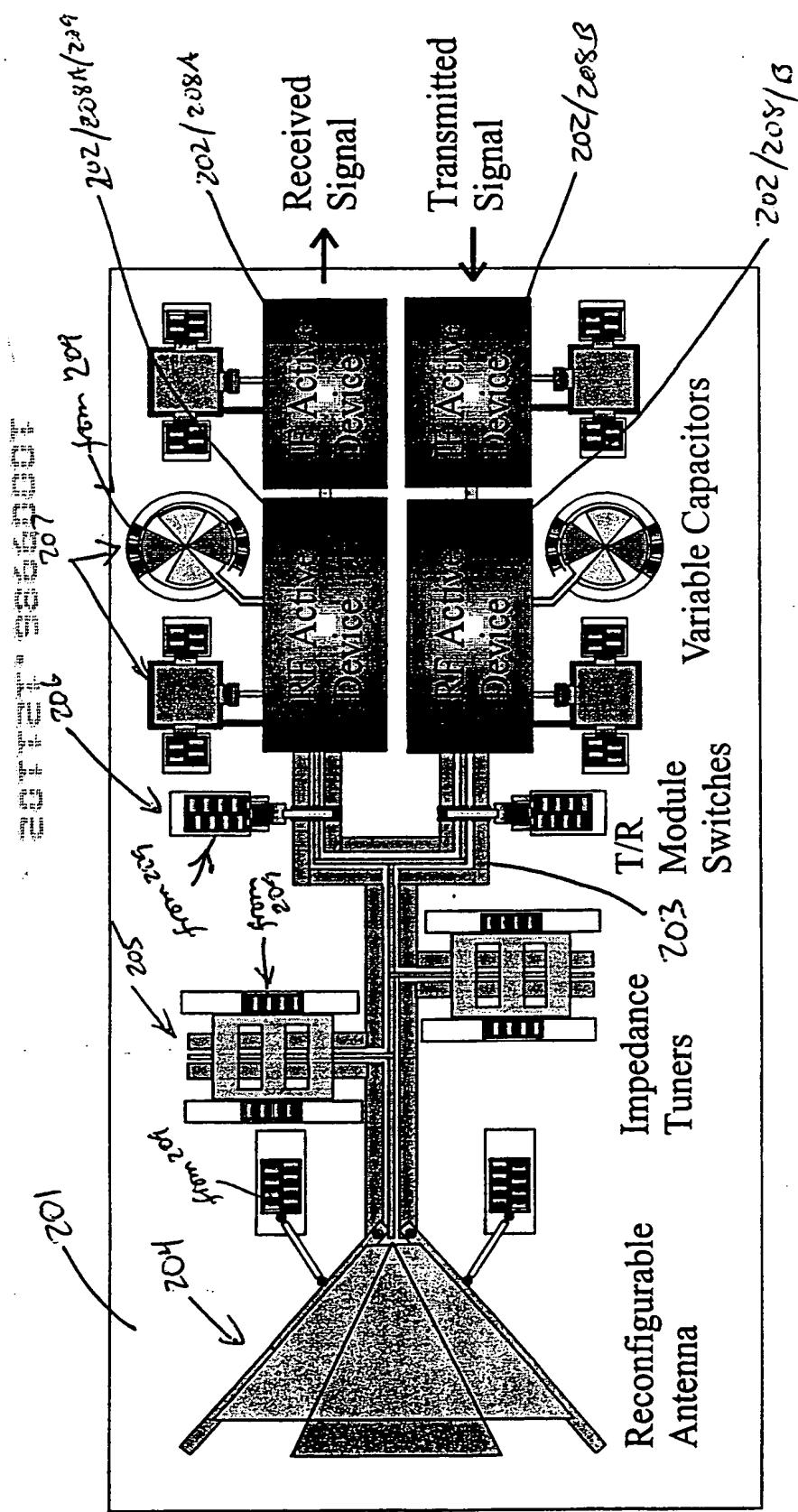


Fig. 2

10/009986

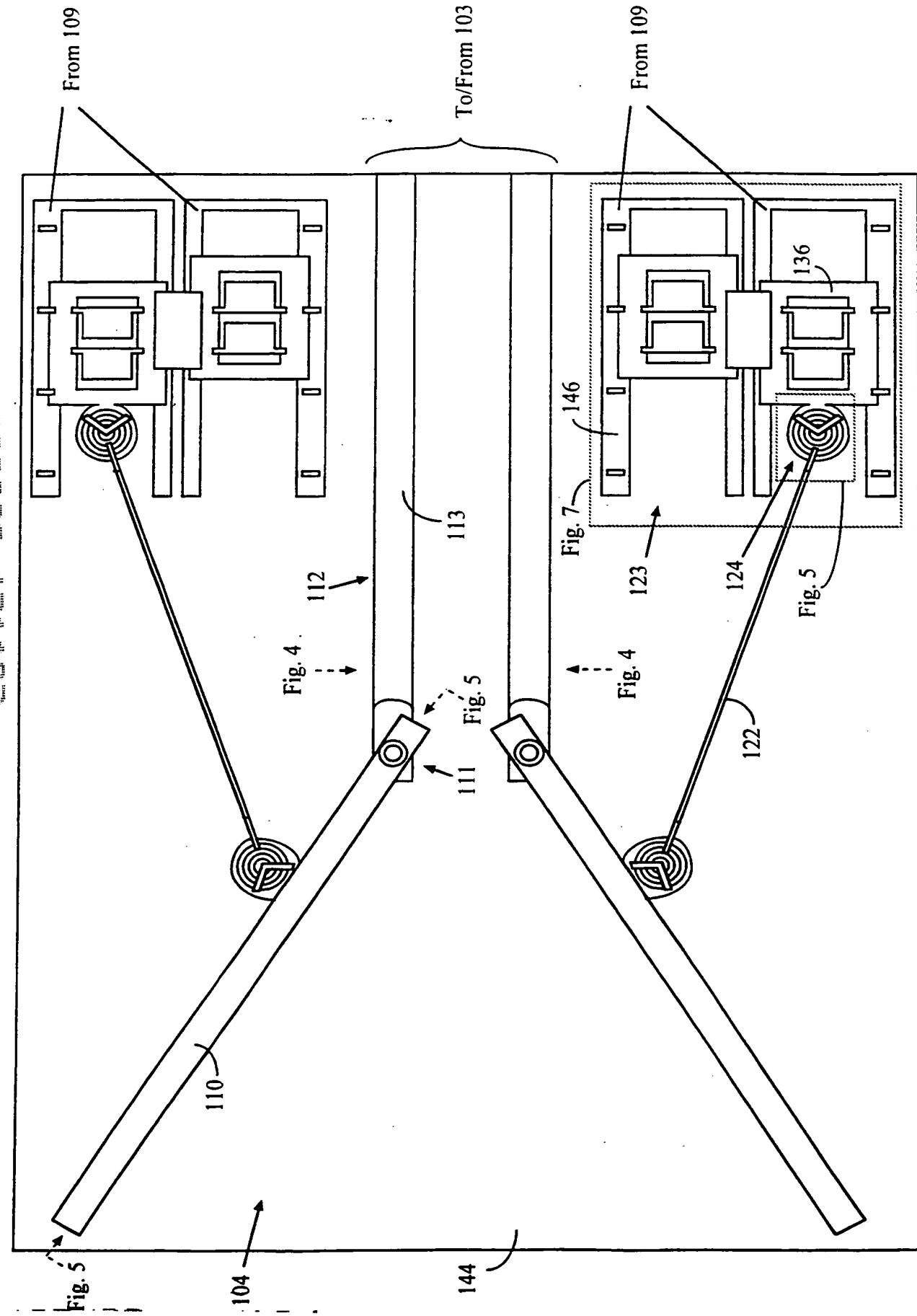


Fig. 3

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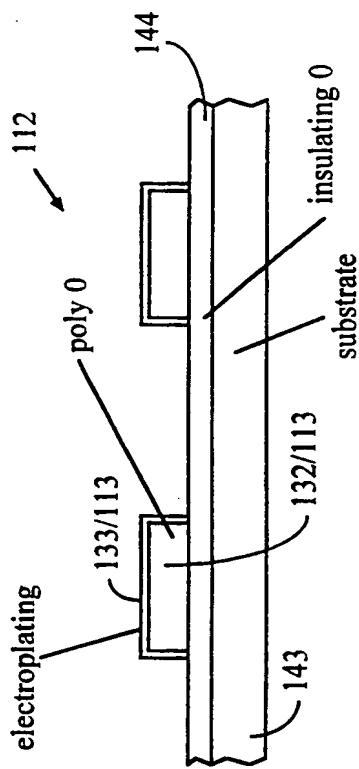


Fig. 4

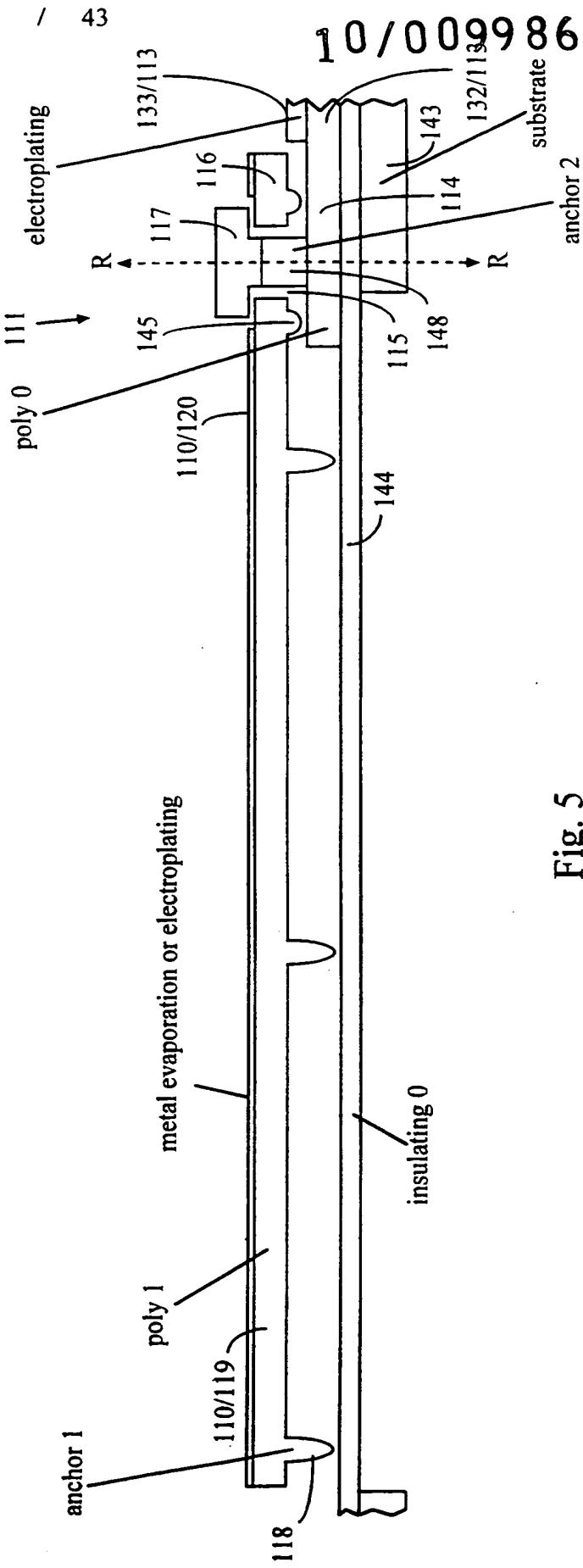


Fig. 5

10/009986

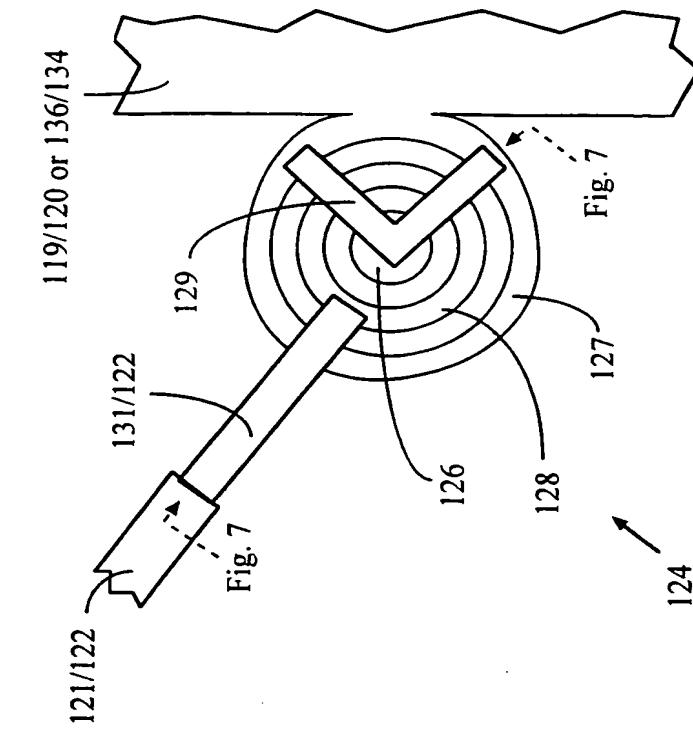


Fig. 6

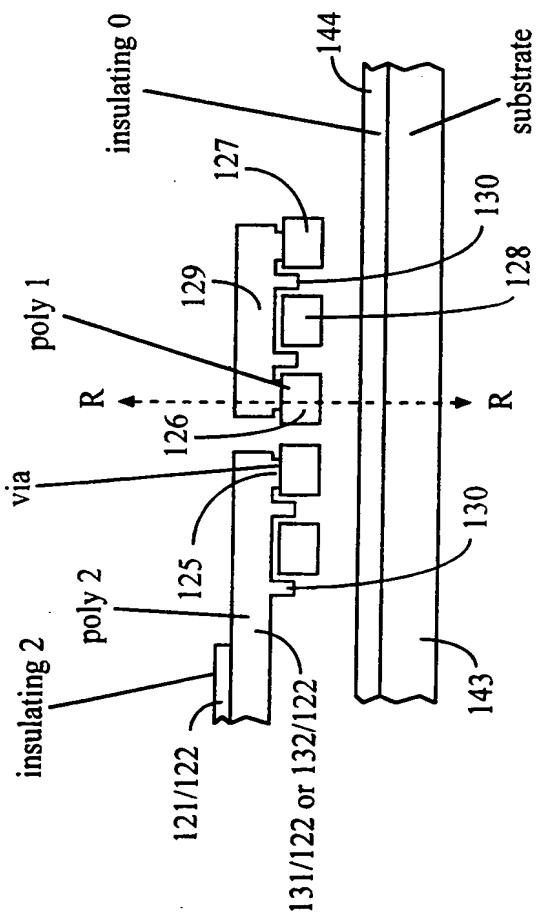
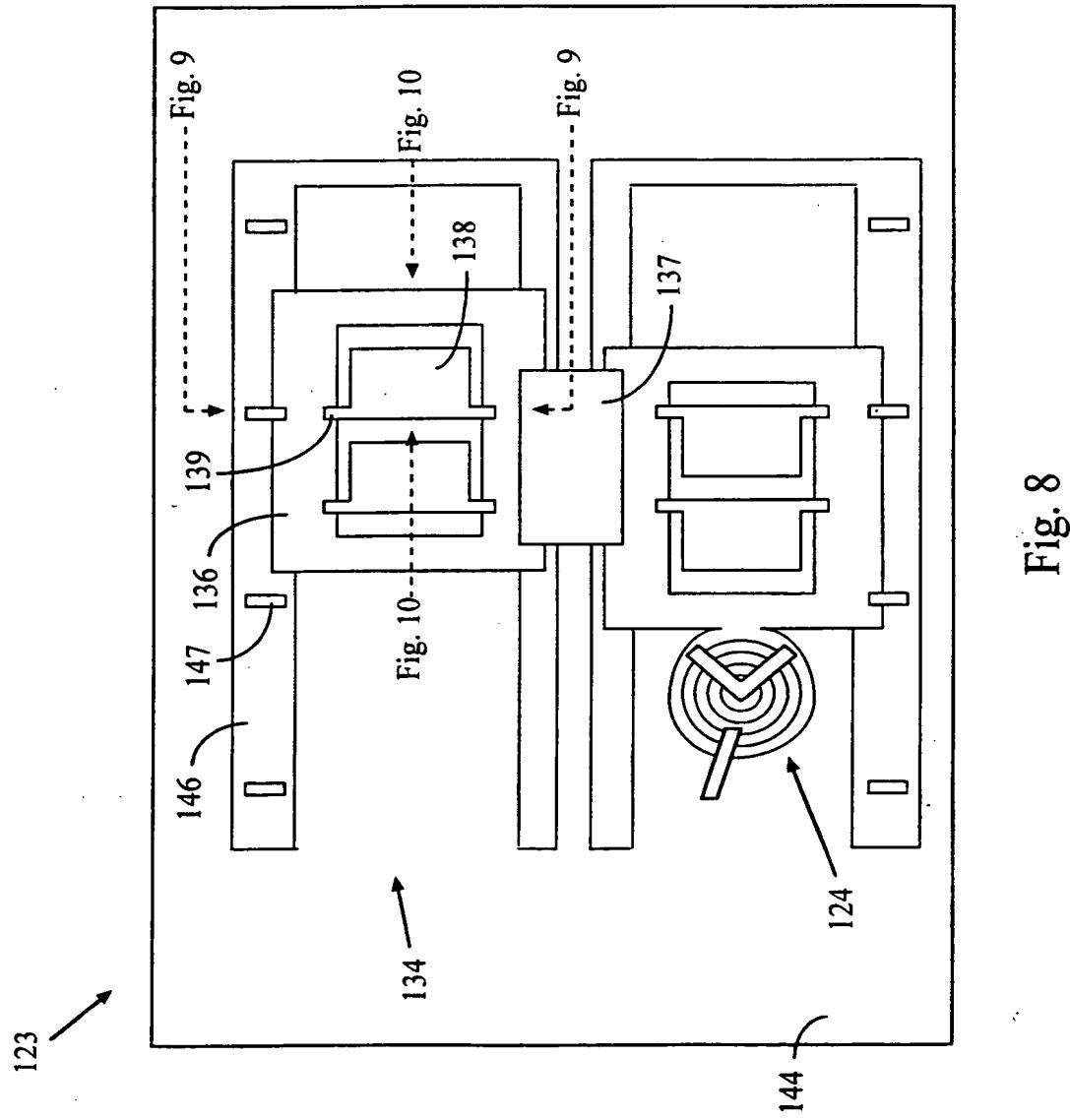


Fig. 7



10/009986

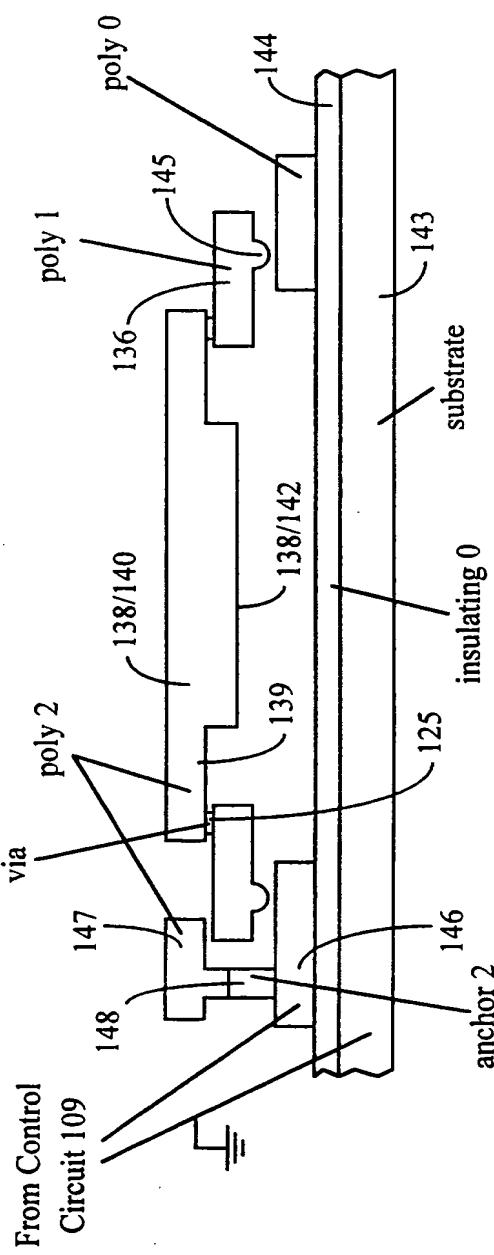


Fig. 9

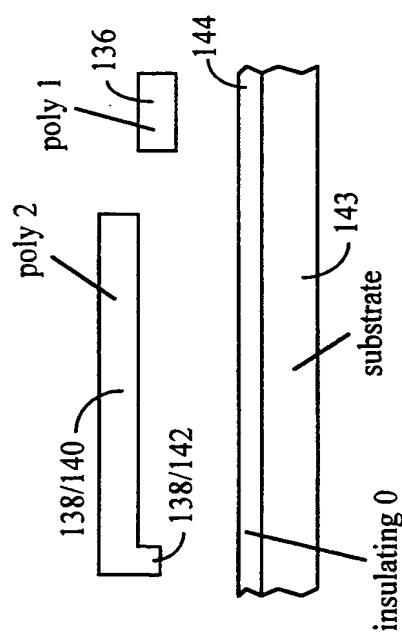
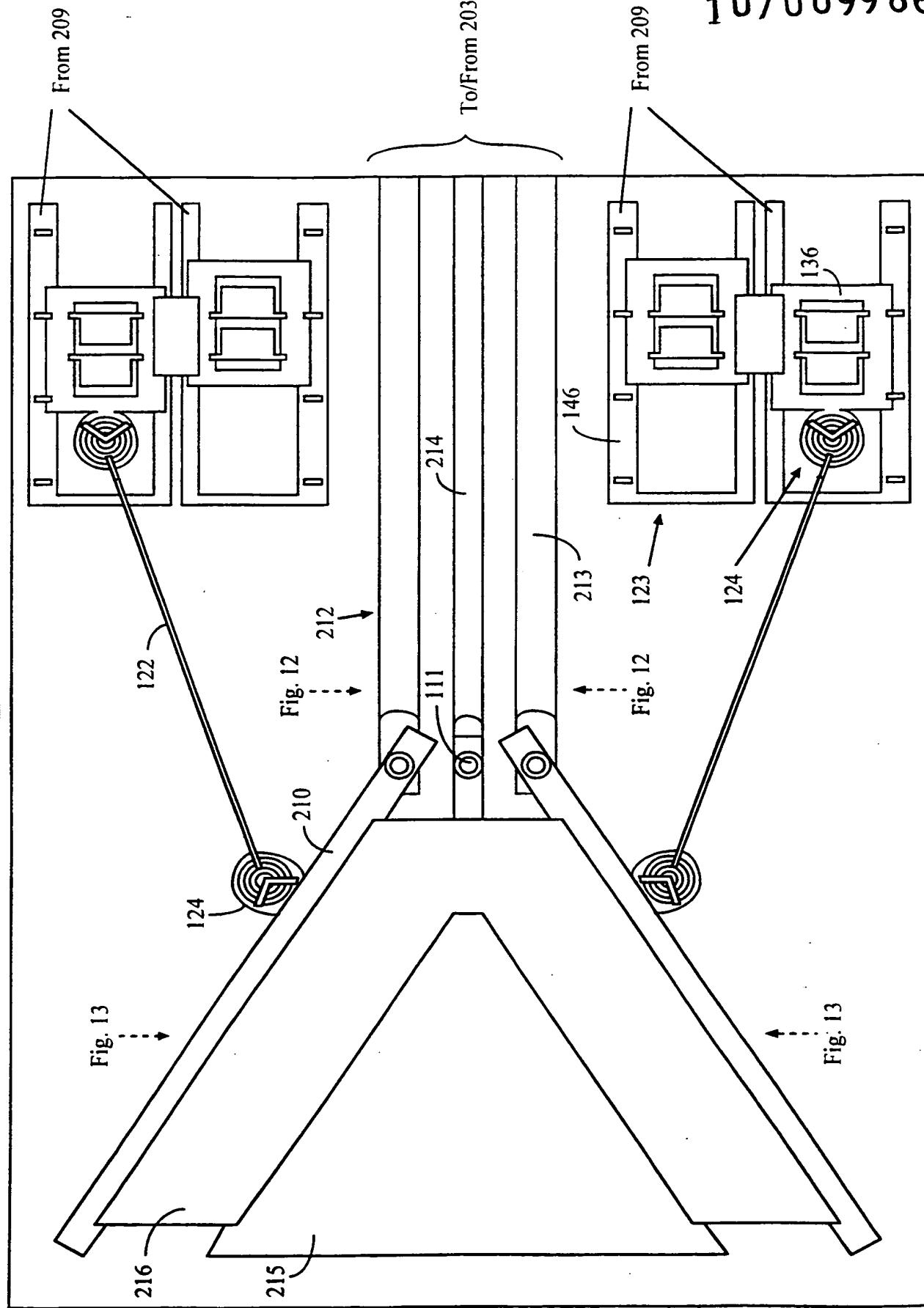


Fig. 10

10/009986

Fig. 11



10/009986

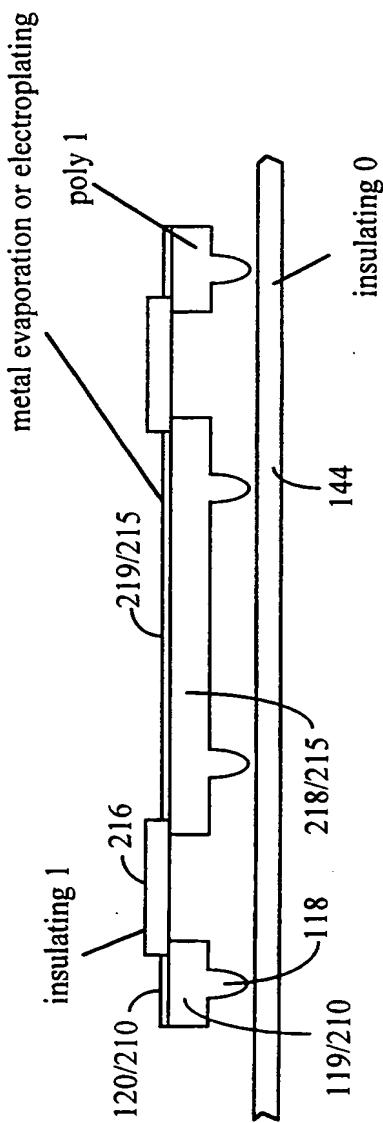


Fig. 13

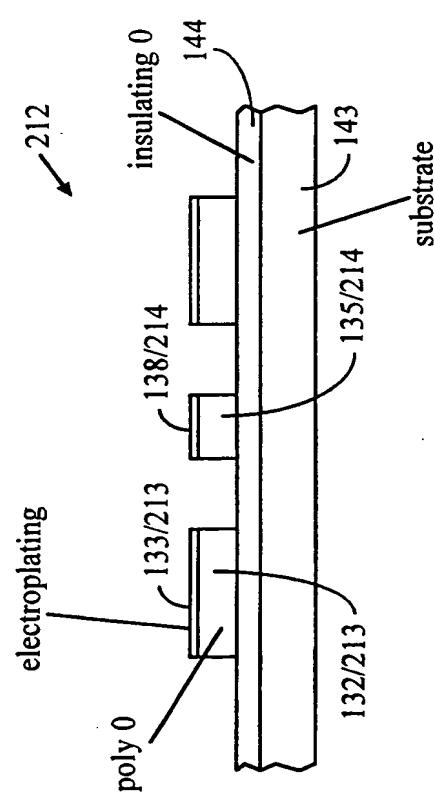


Fig. 12

10/009986

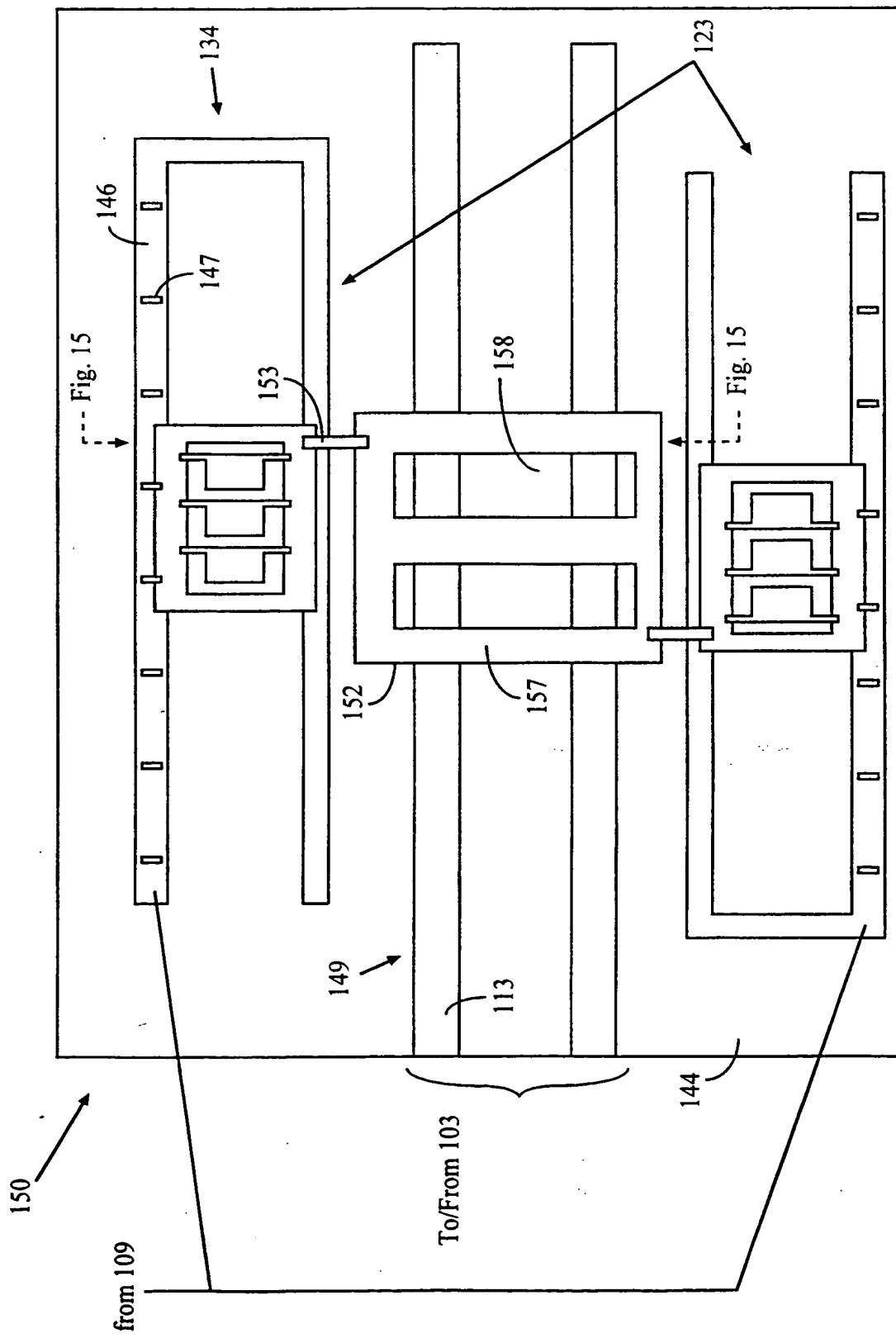


Fig. 14

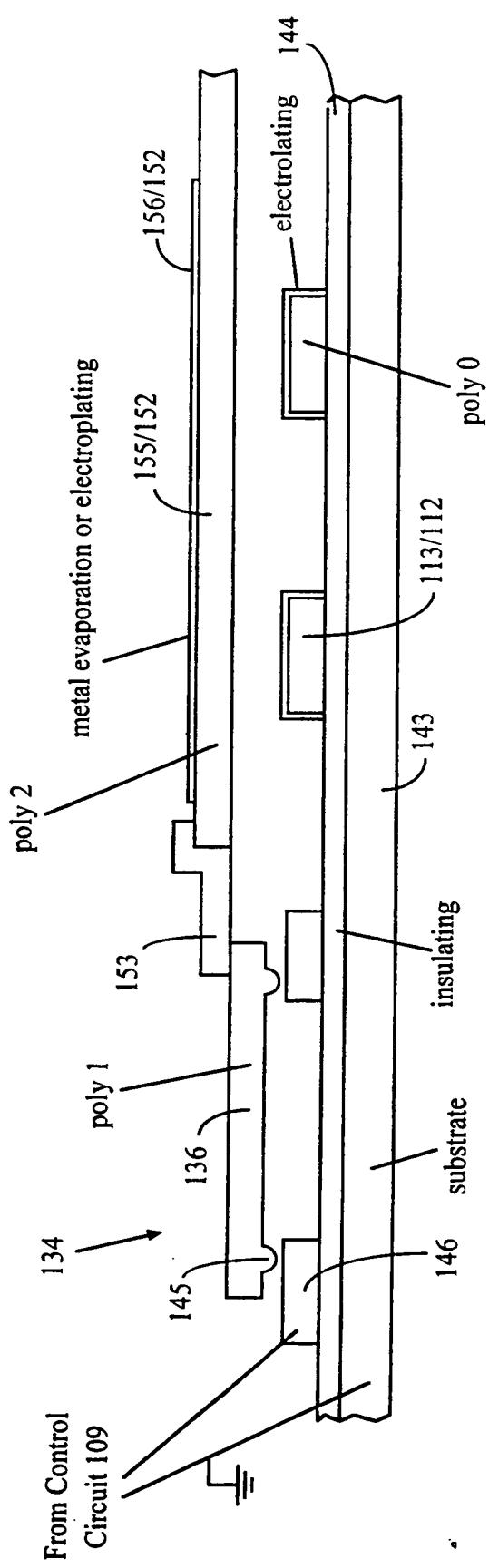


Fig. 15

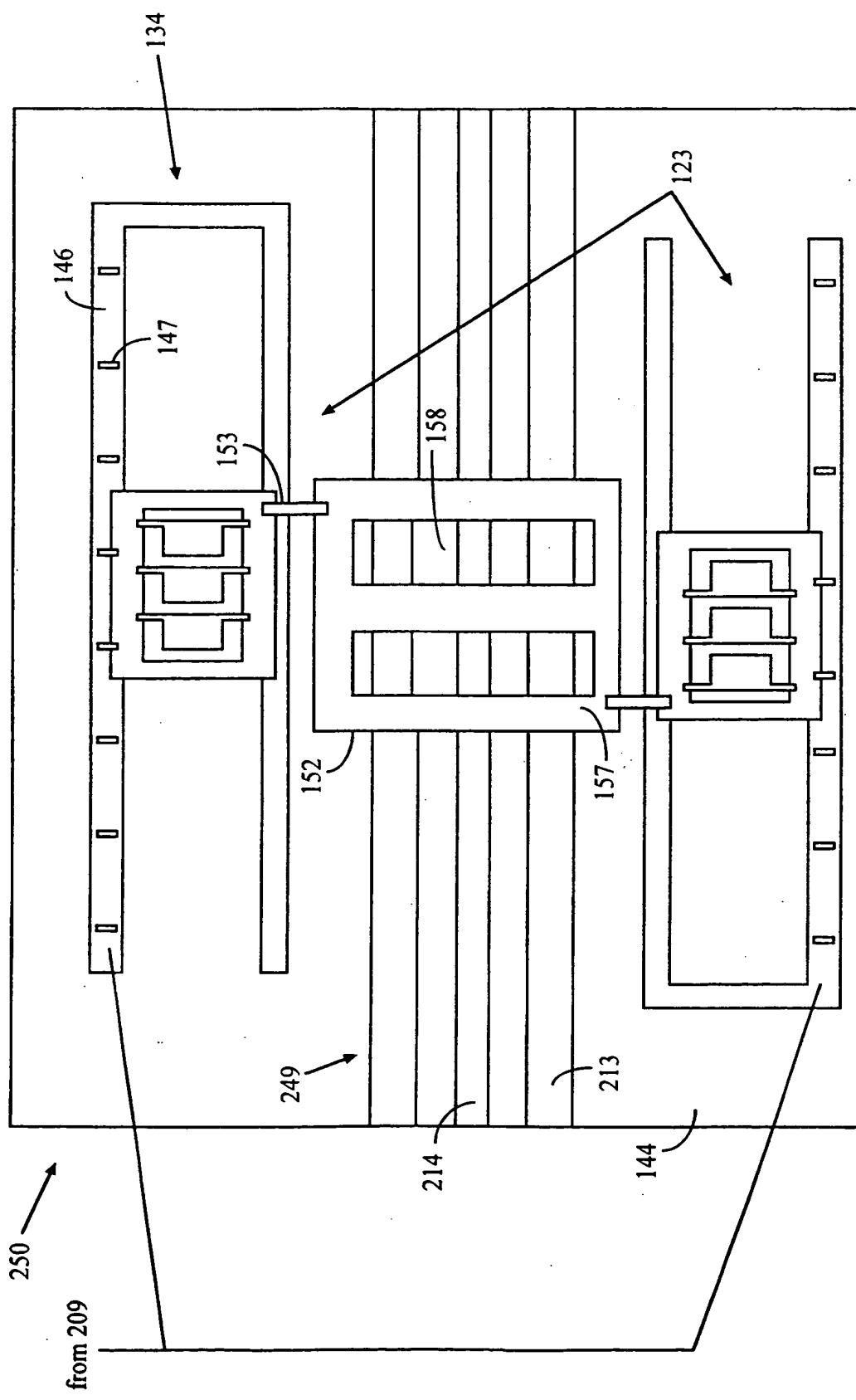


Fig. 16

10/009986

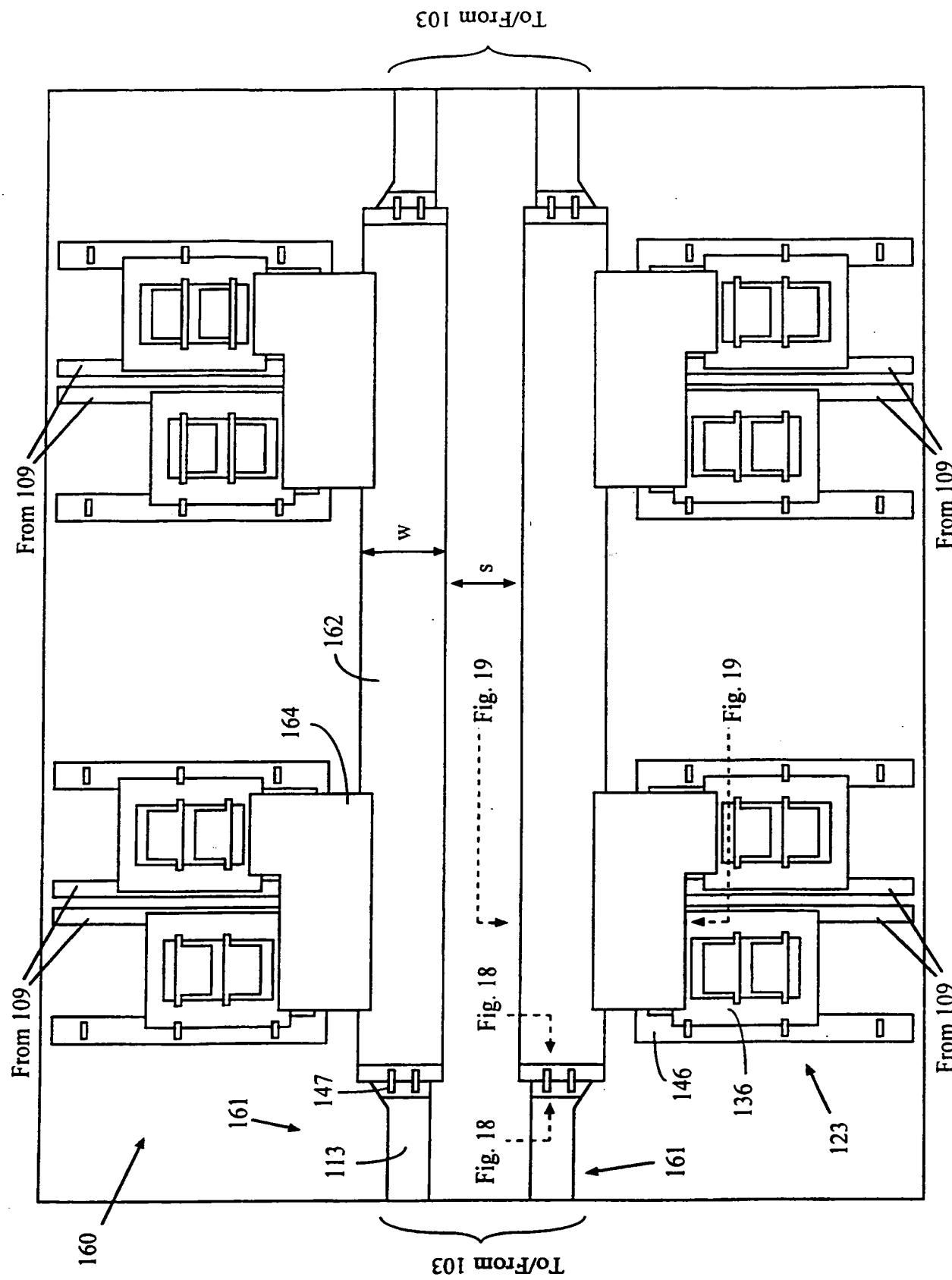


Fig. 17

10/009986

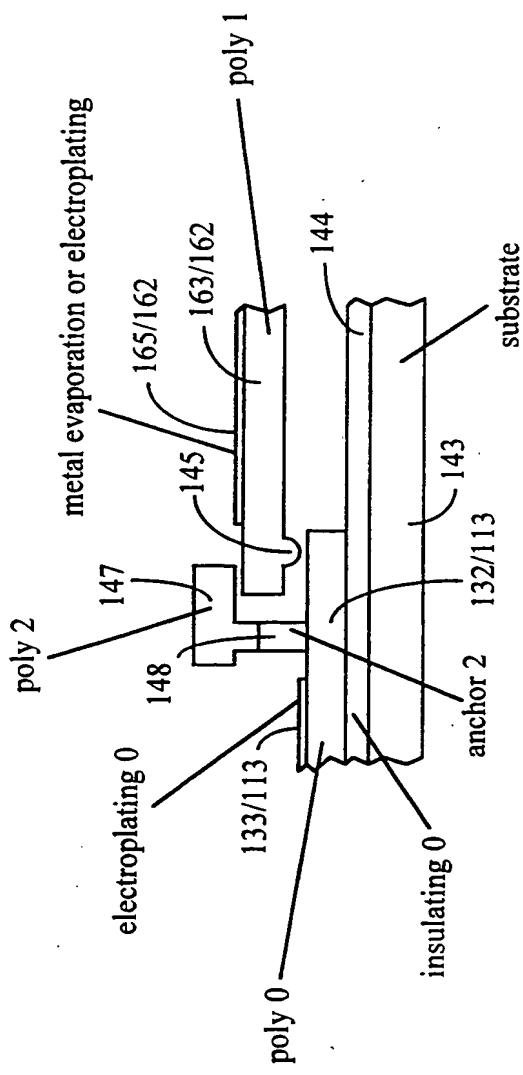


Fig. 18

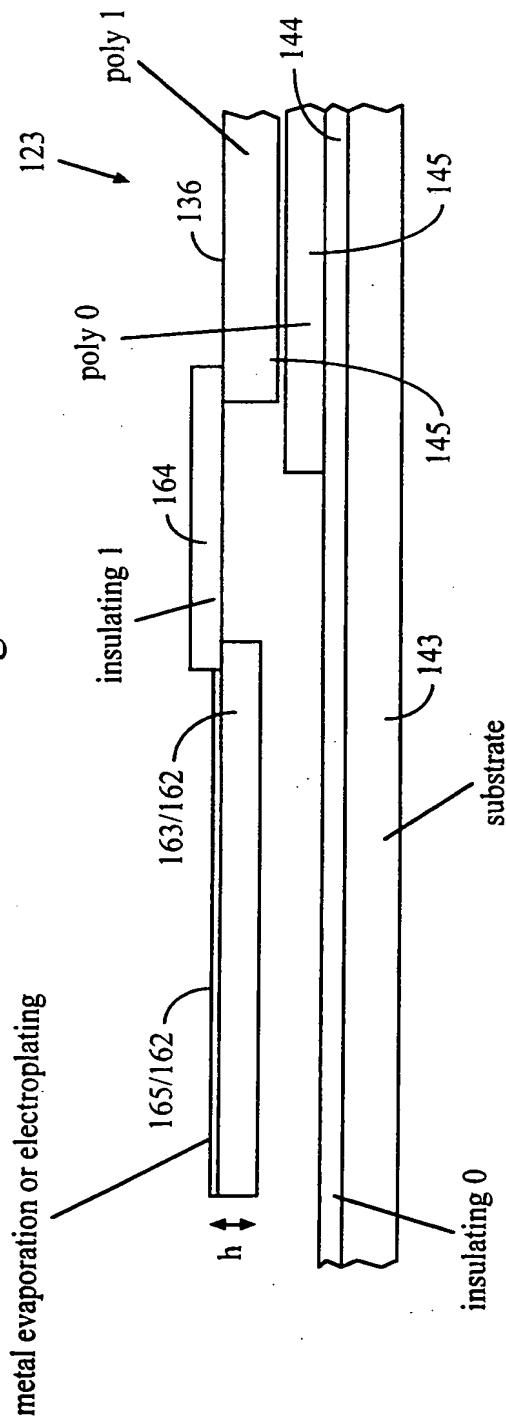


Fig. 19

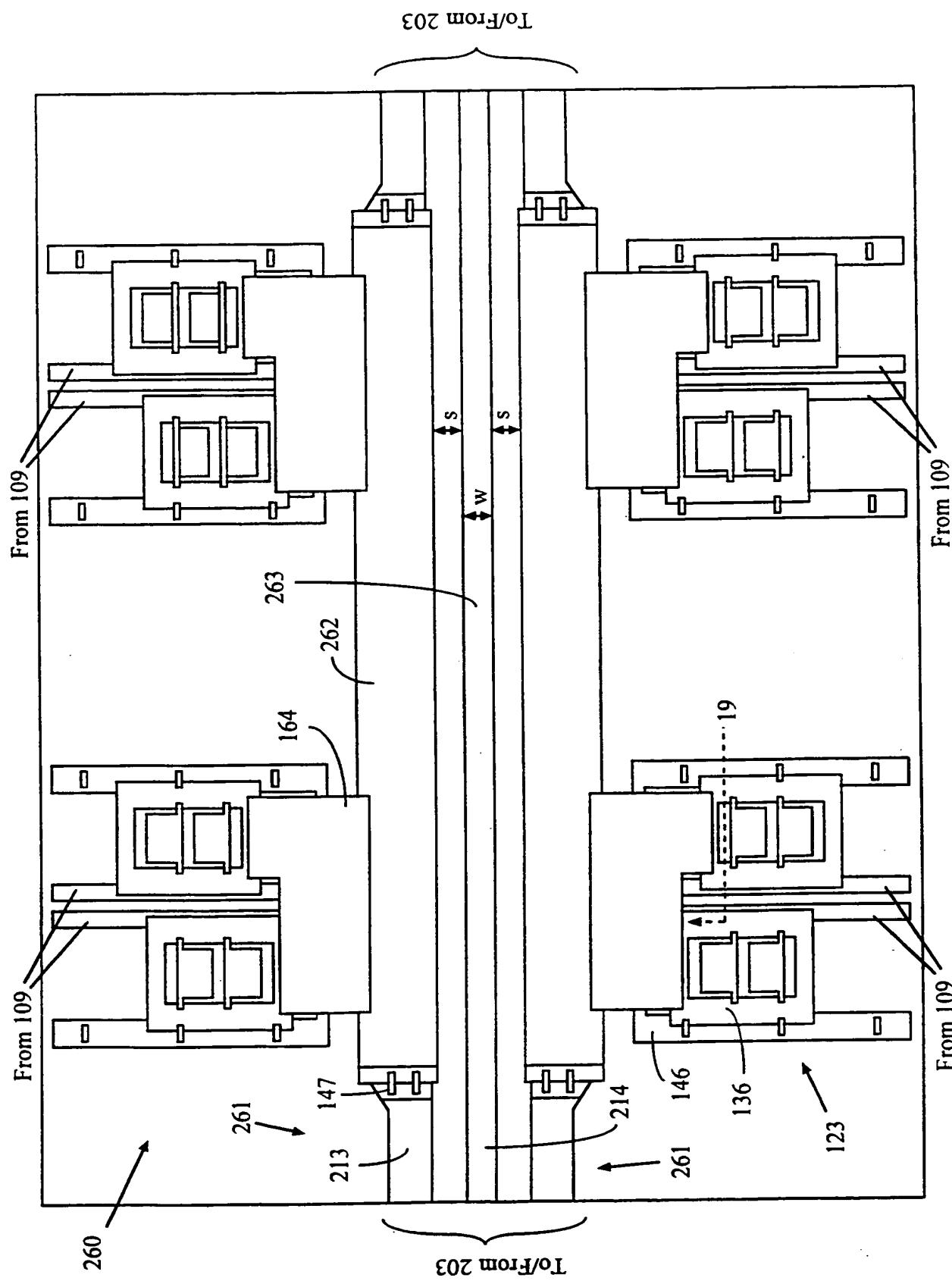


Fig. 20

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To/From 103

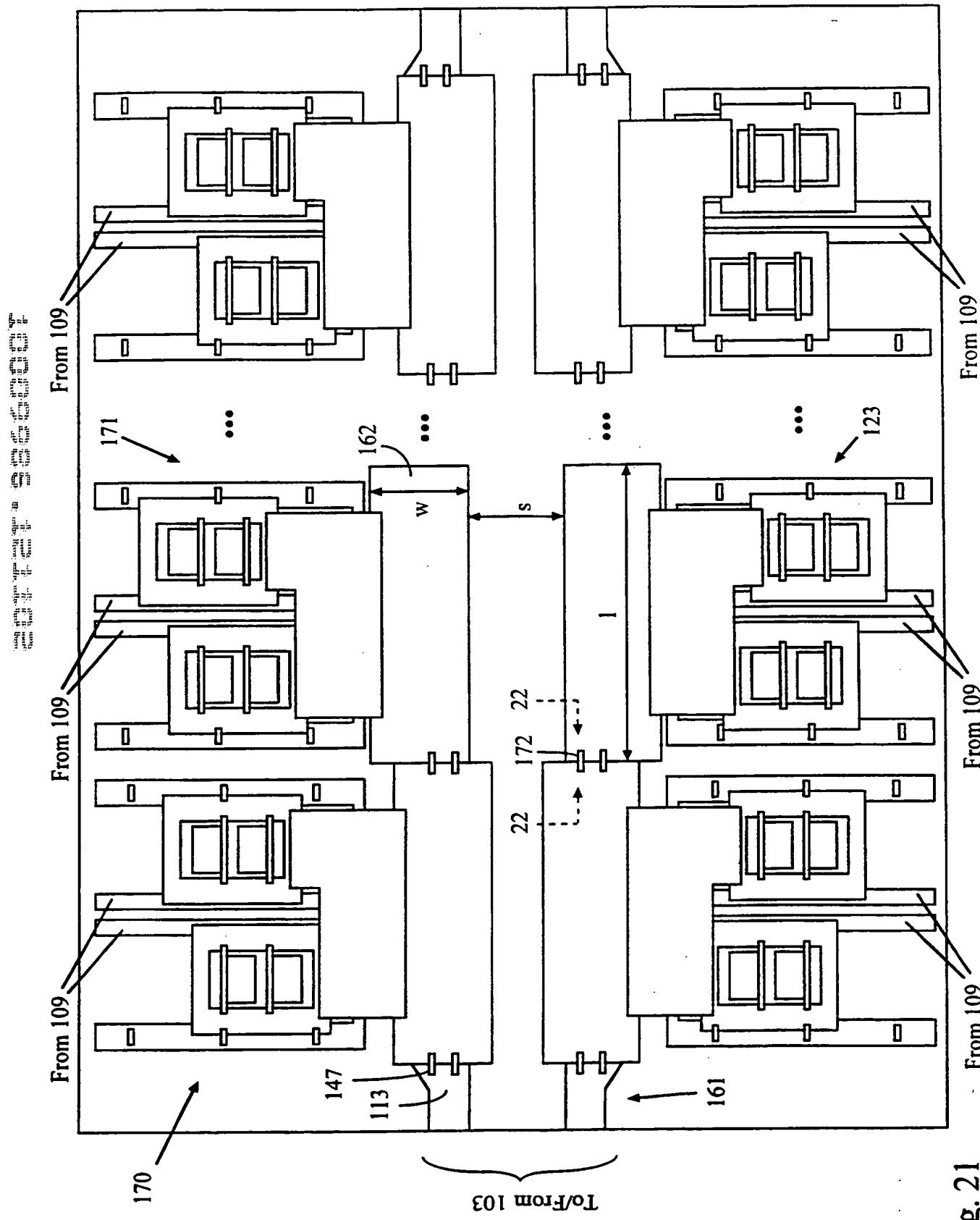


Fig. 21

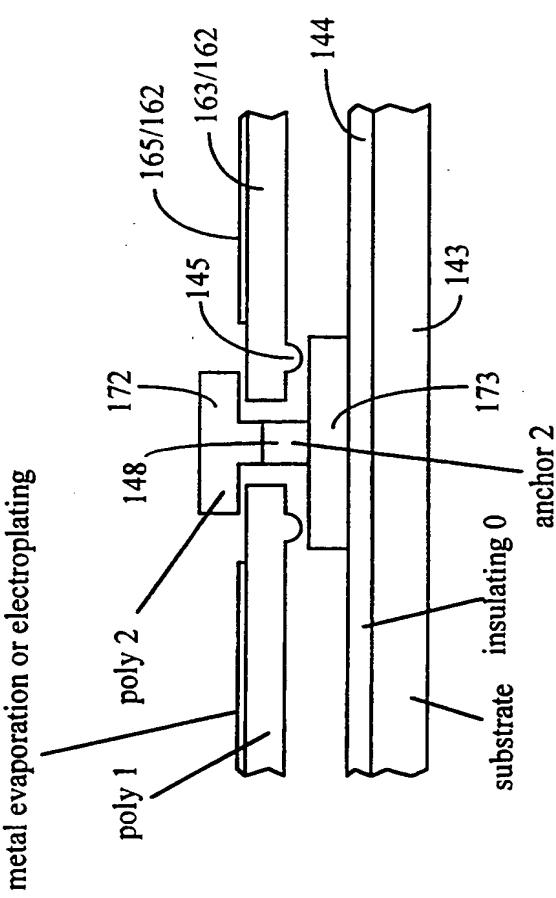


Fig. 22

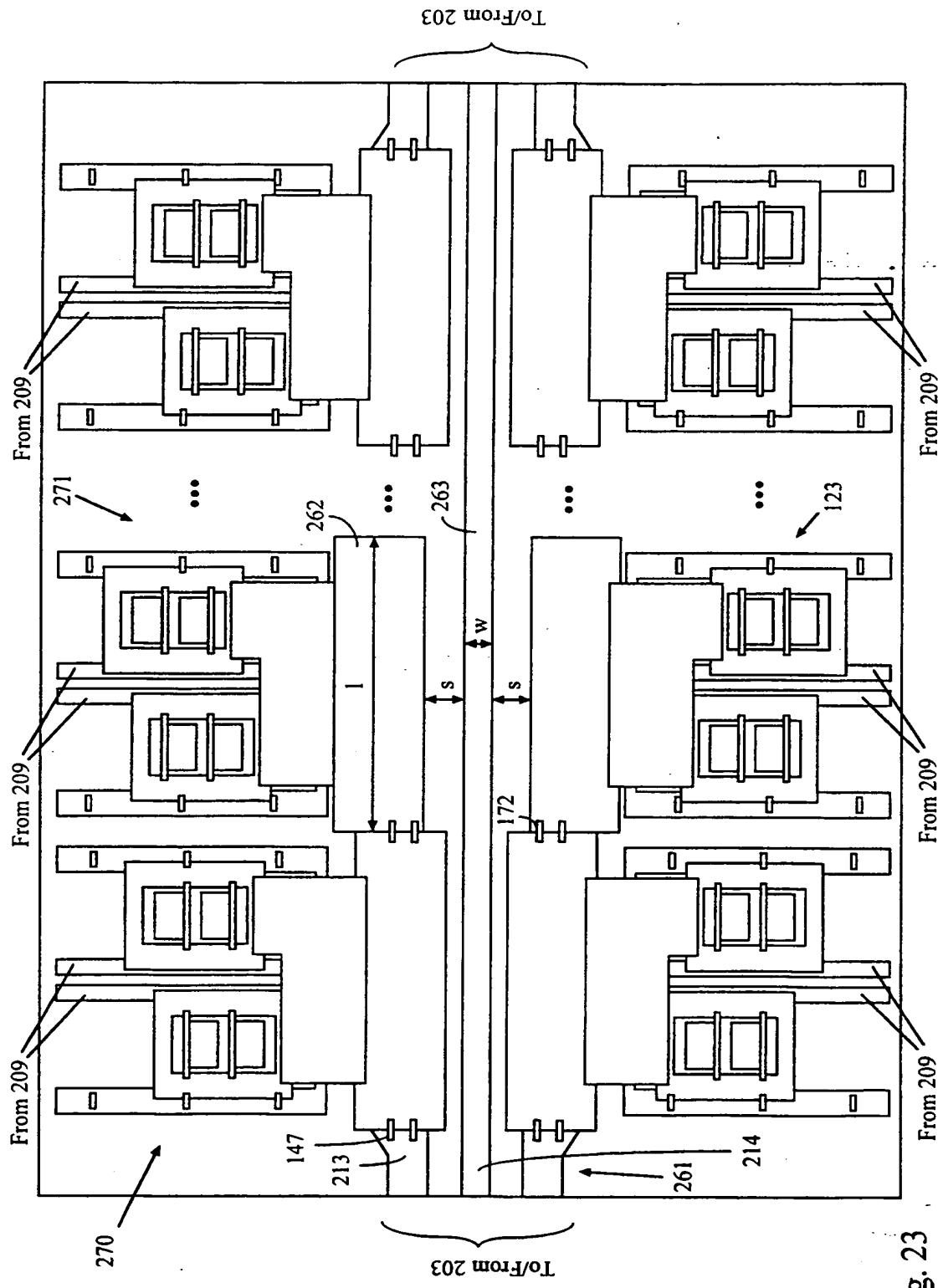


Fig. 23

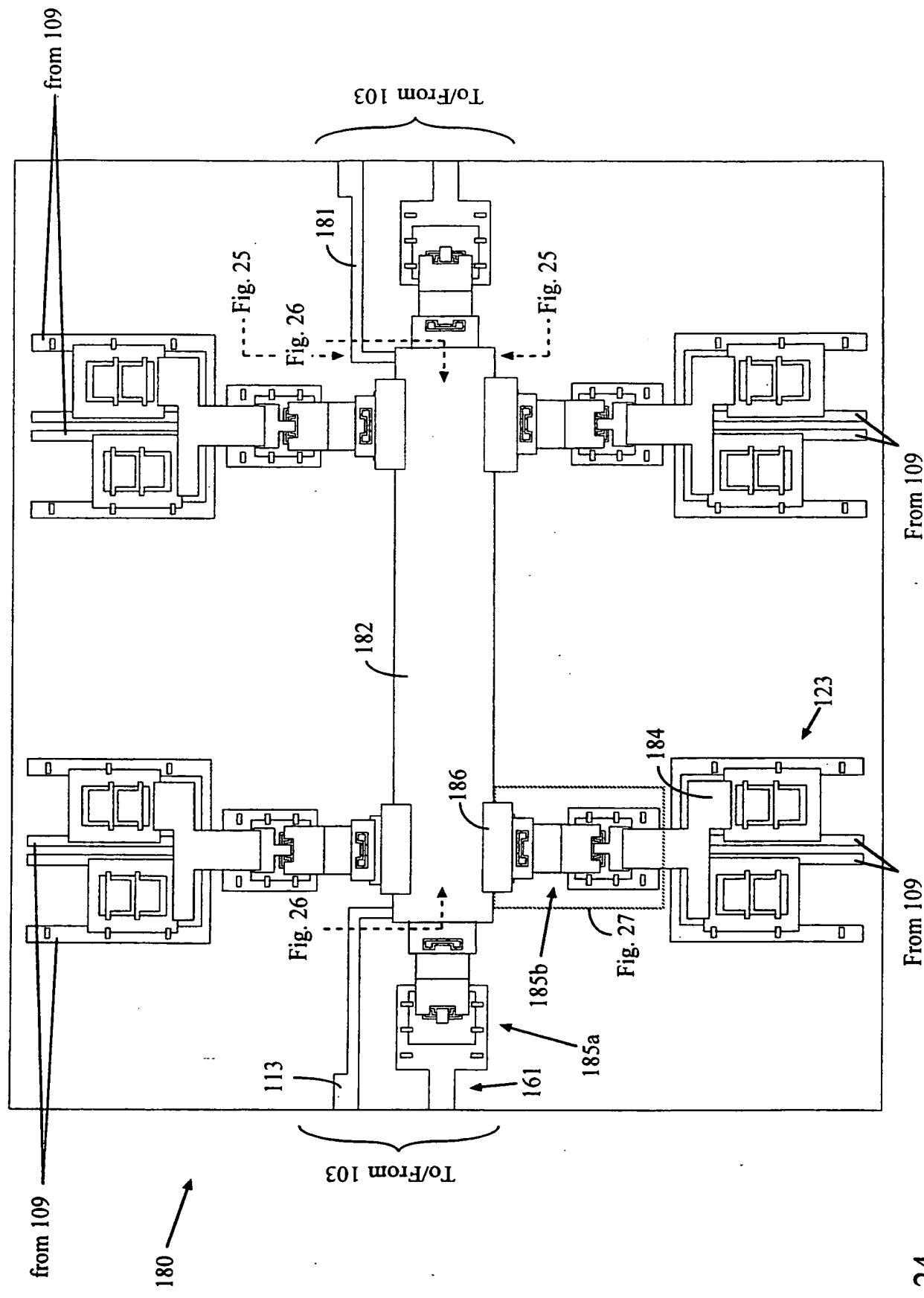


Fig. 24

metal evaporation or electroplating

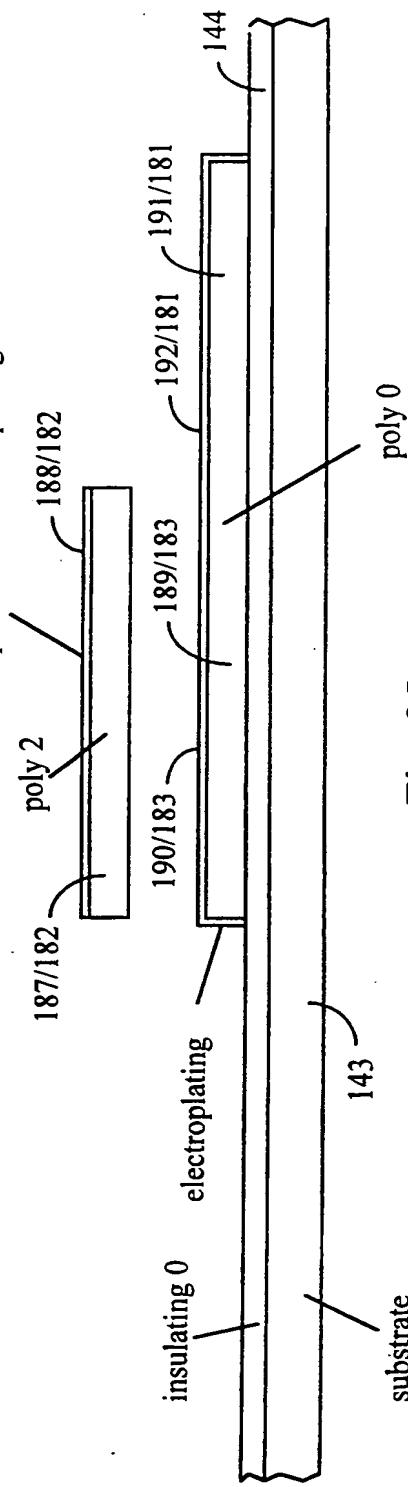


Fig. 25

metal evaporation or electroplating

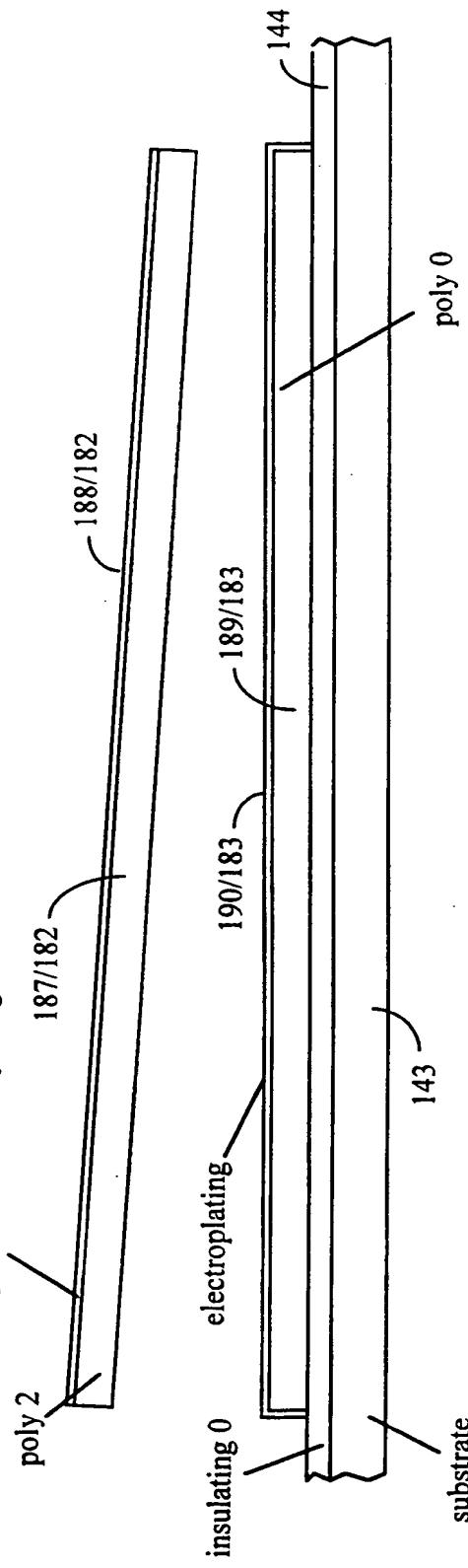
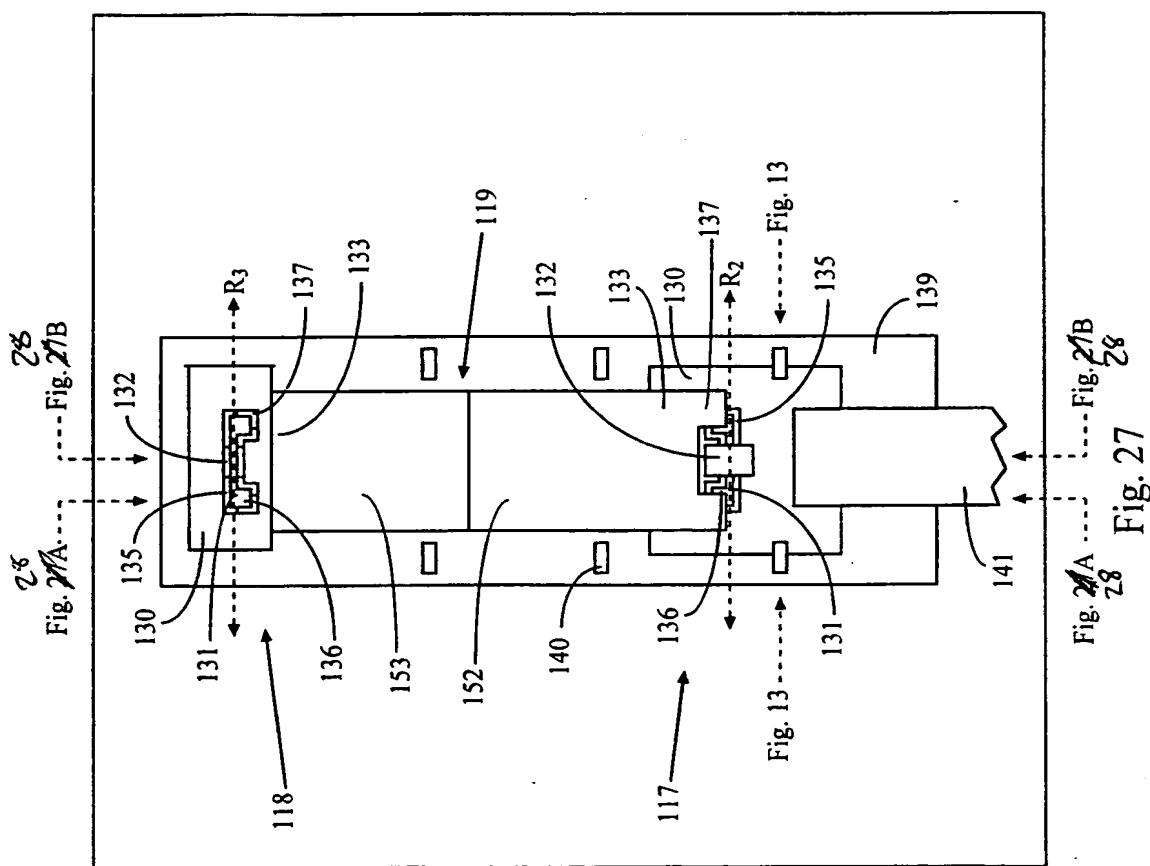


Fig. 26



10/009986

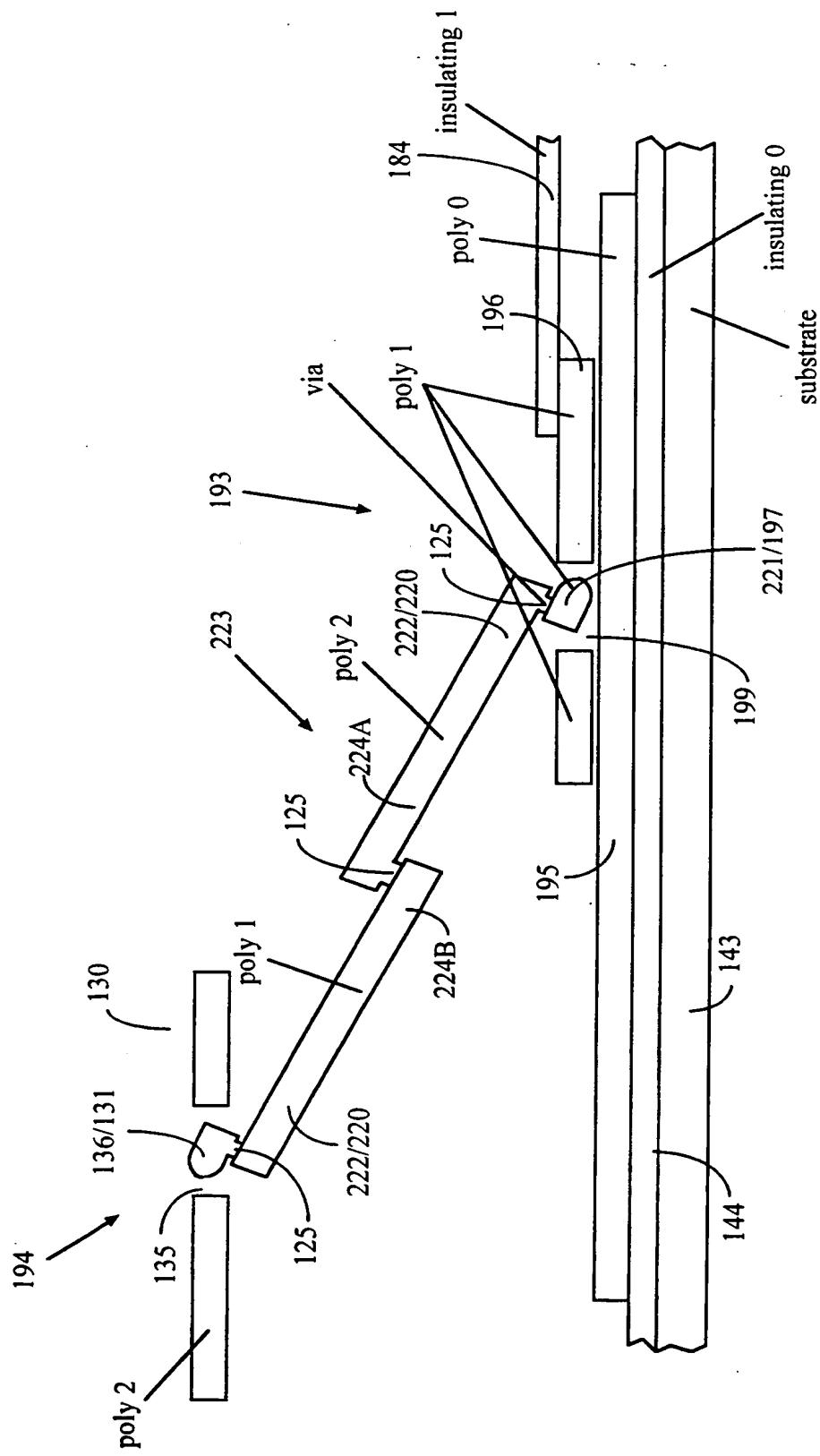


Fig. 28A

10/009986

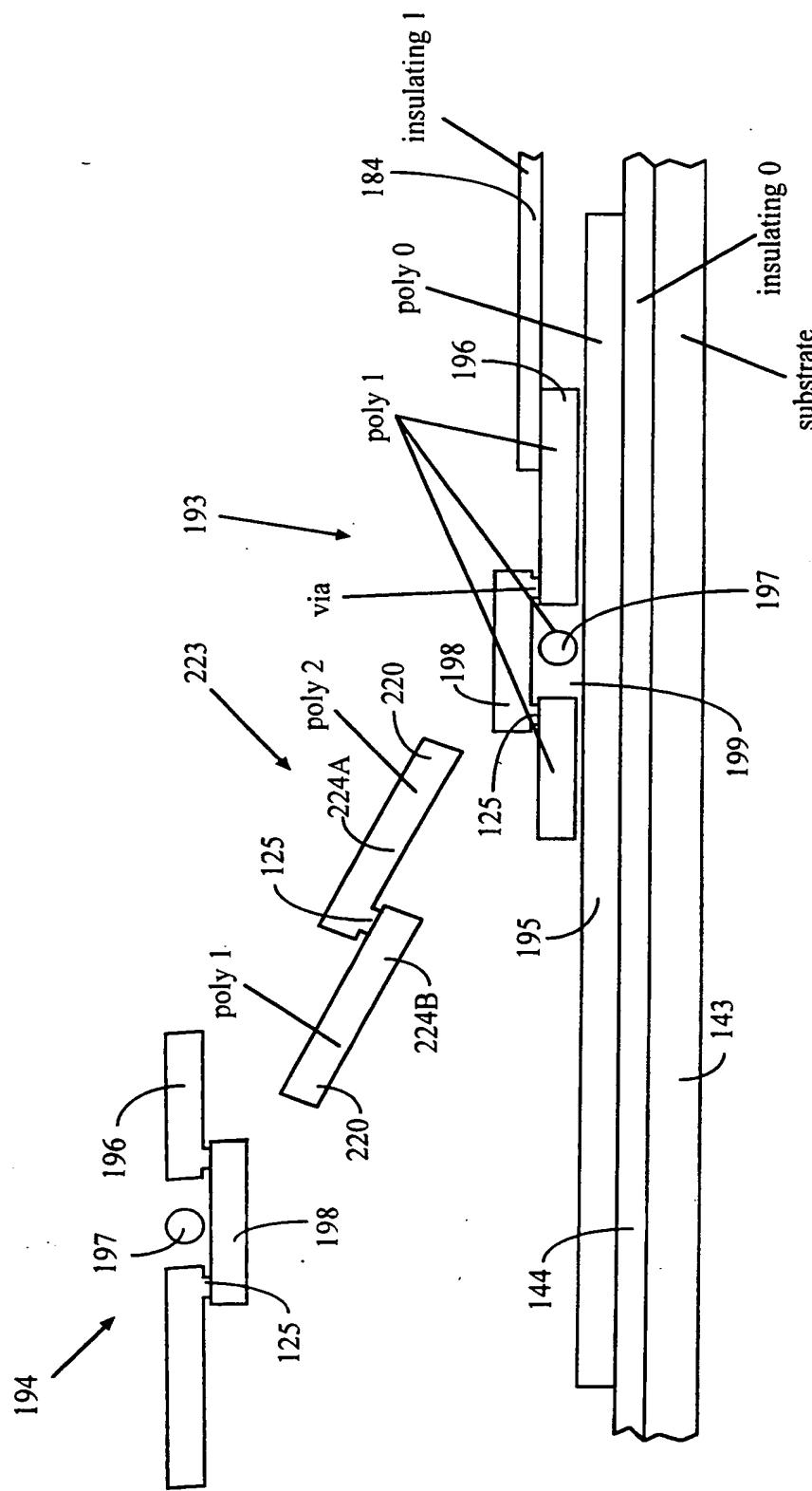


Fig. 28B

10/009986

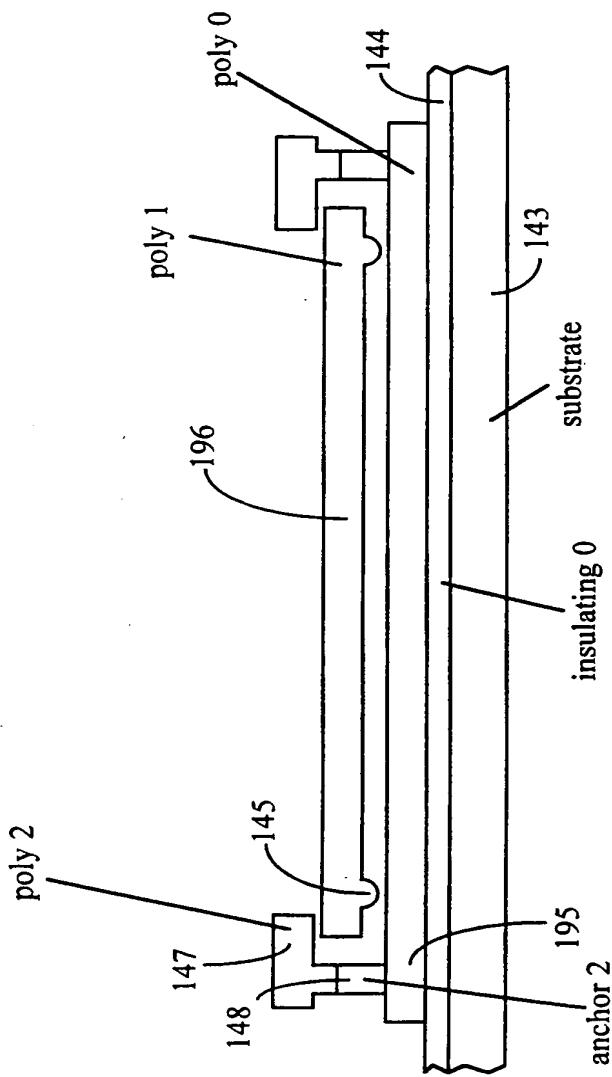


Fig. 29

10/009986

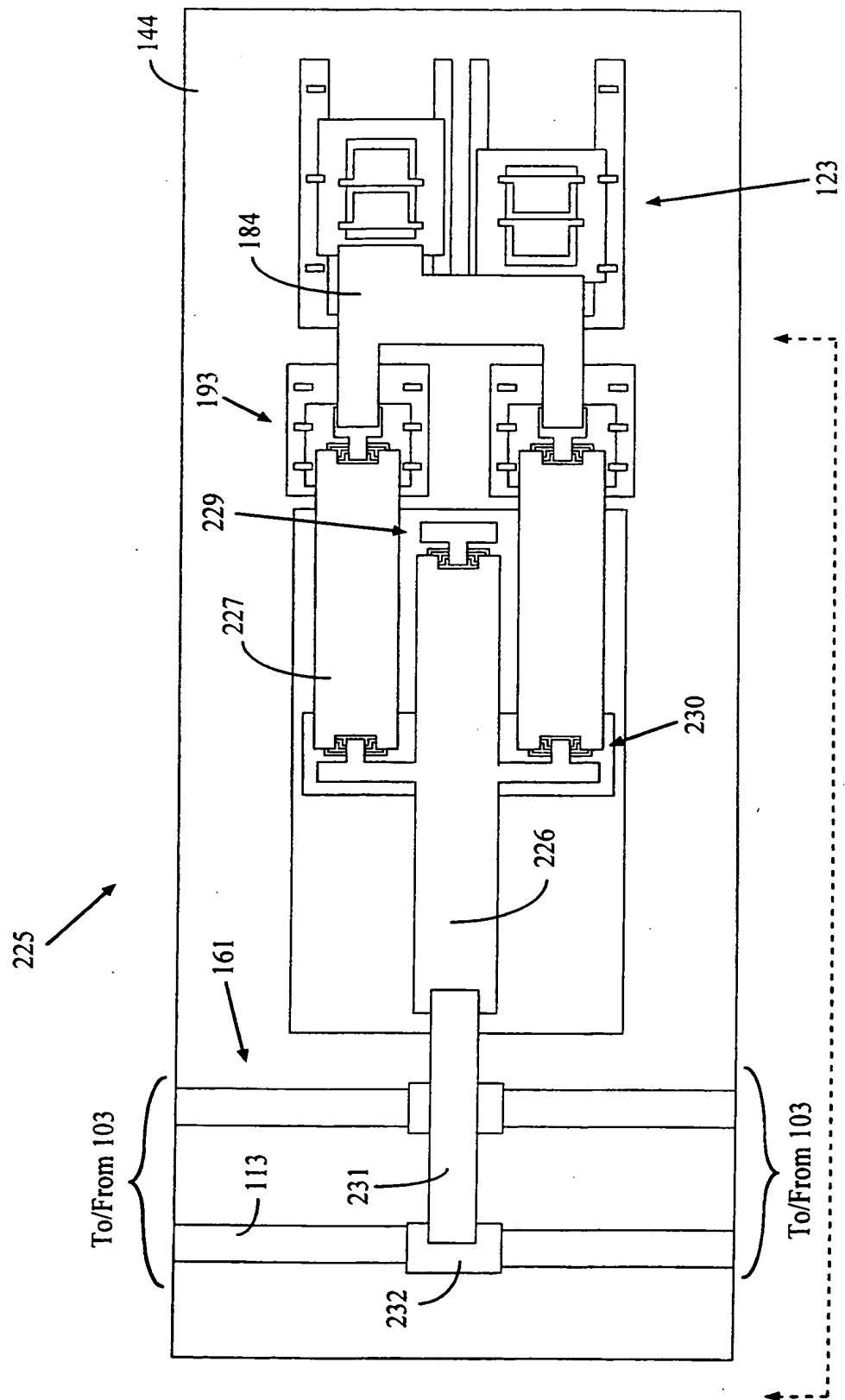


Fig. 30

Fig. 31

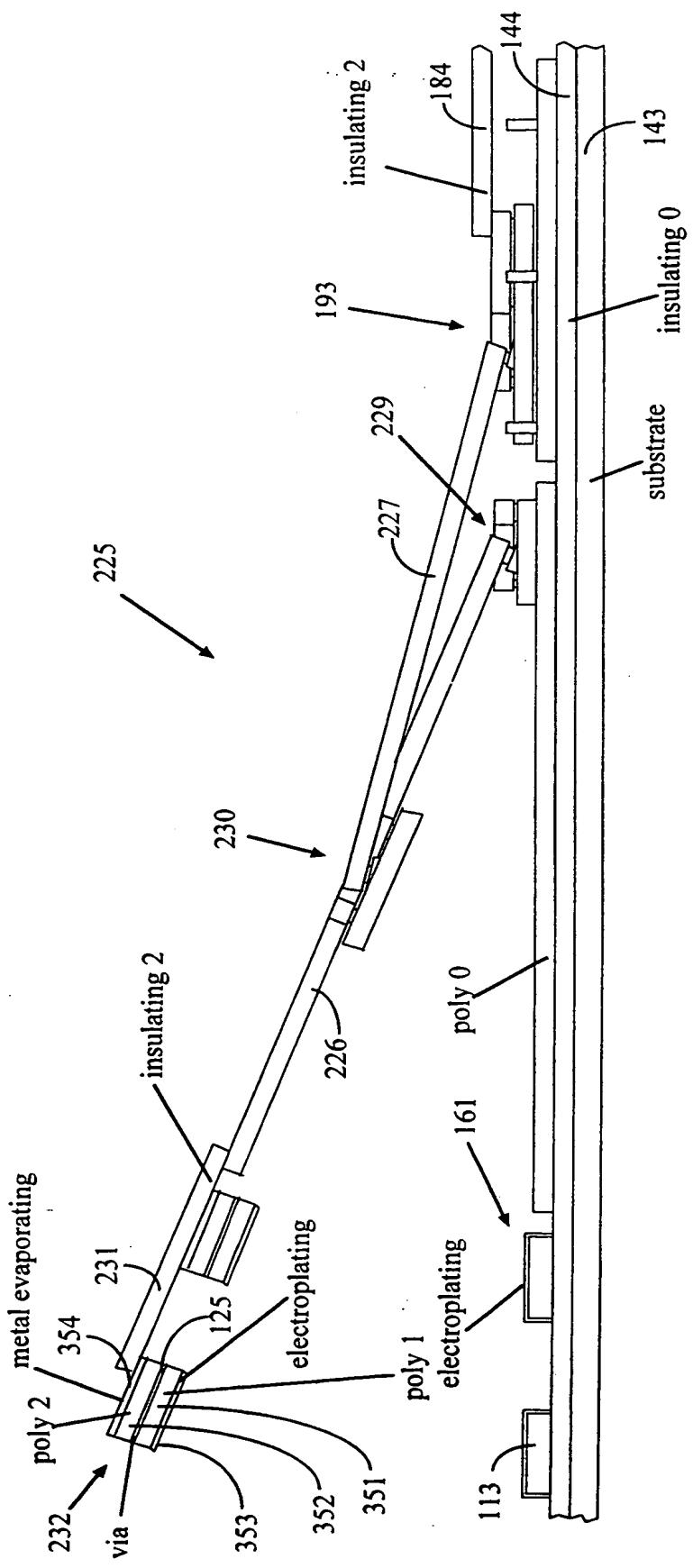


Fig. 31

10/009986

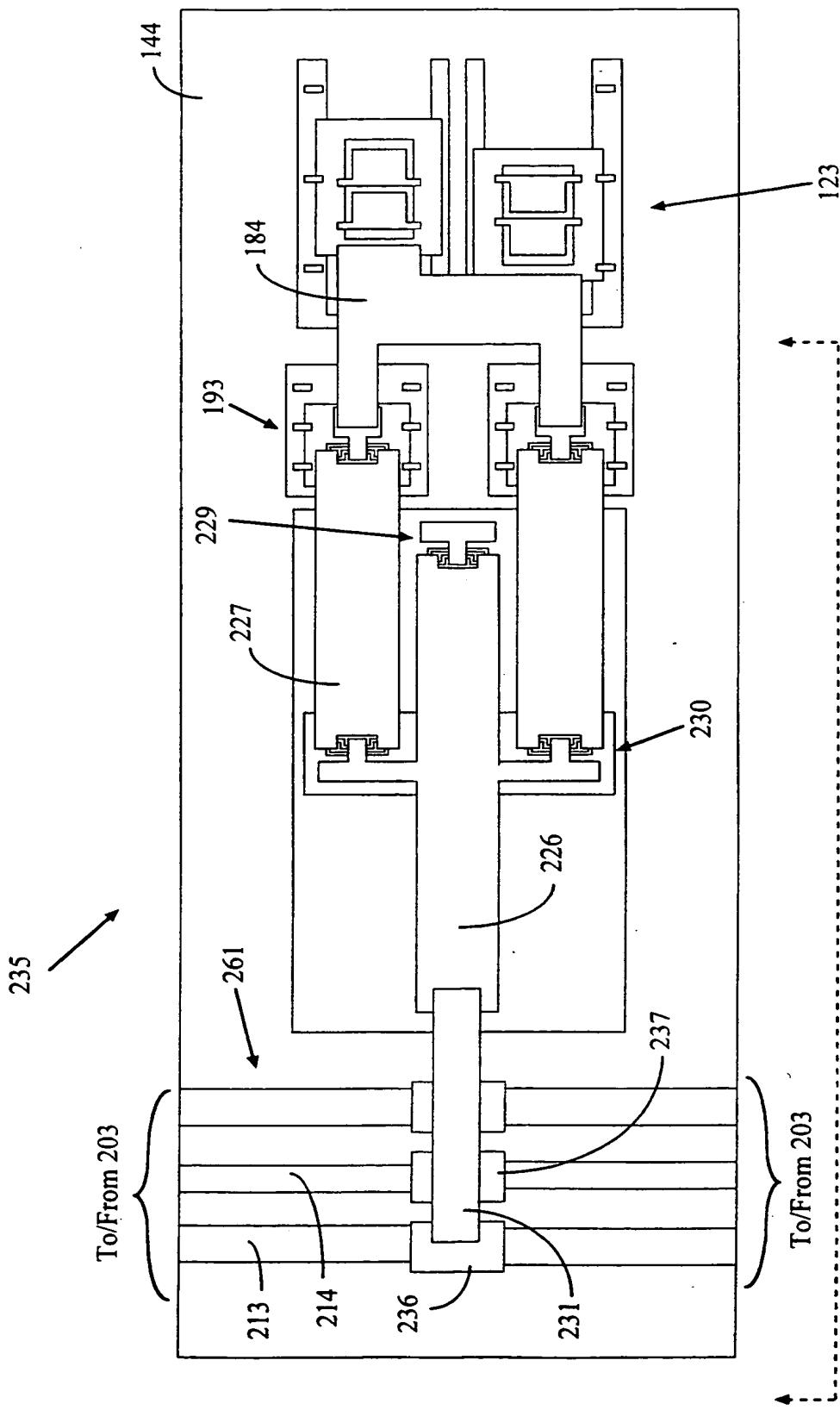


Fig. 32

Fig. 33

10/009986.

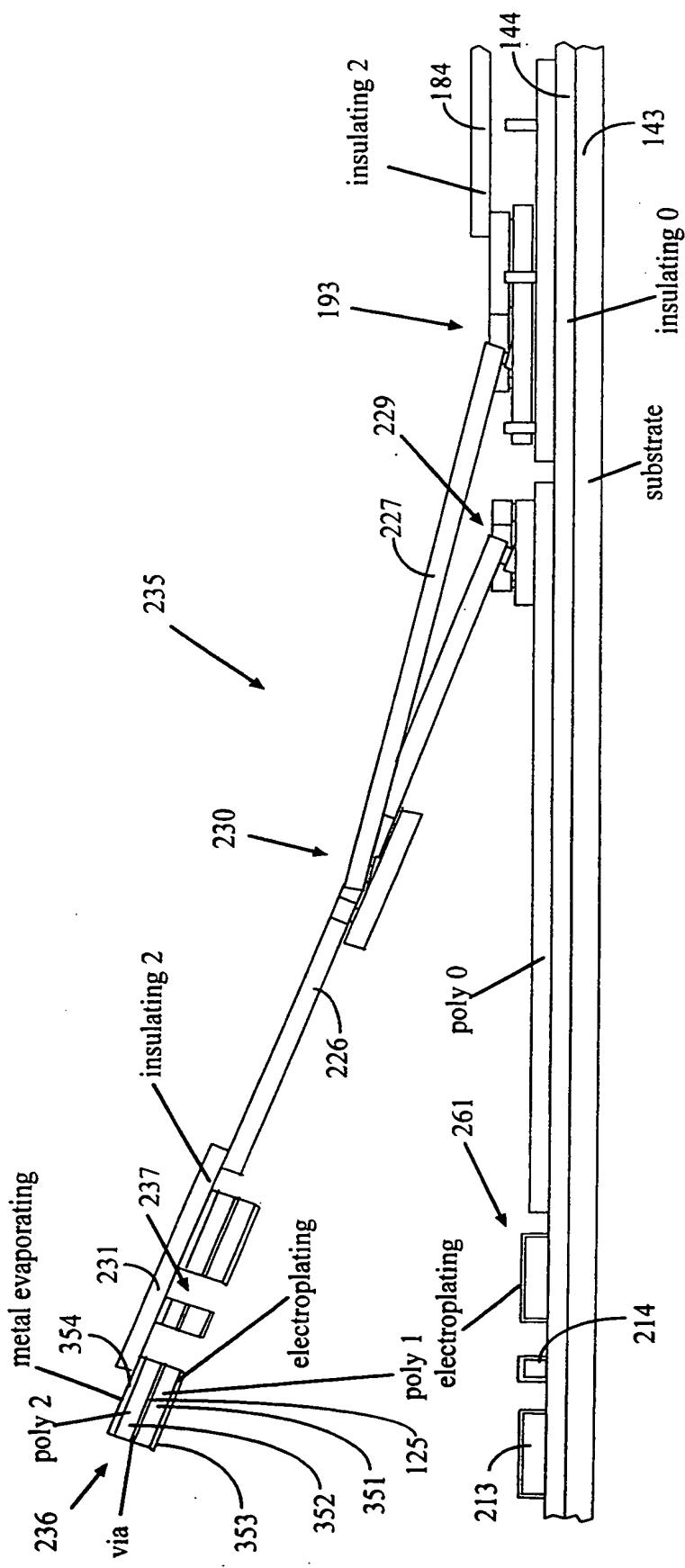
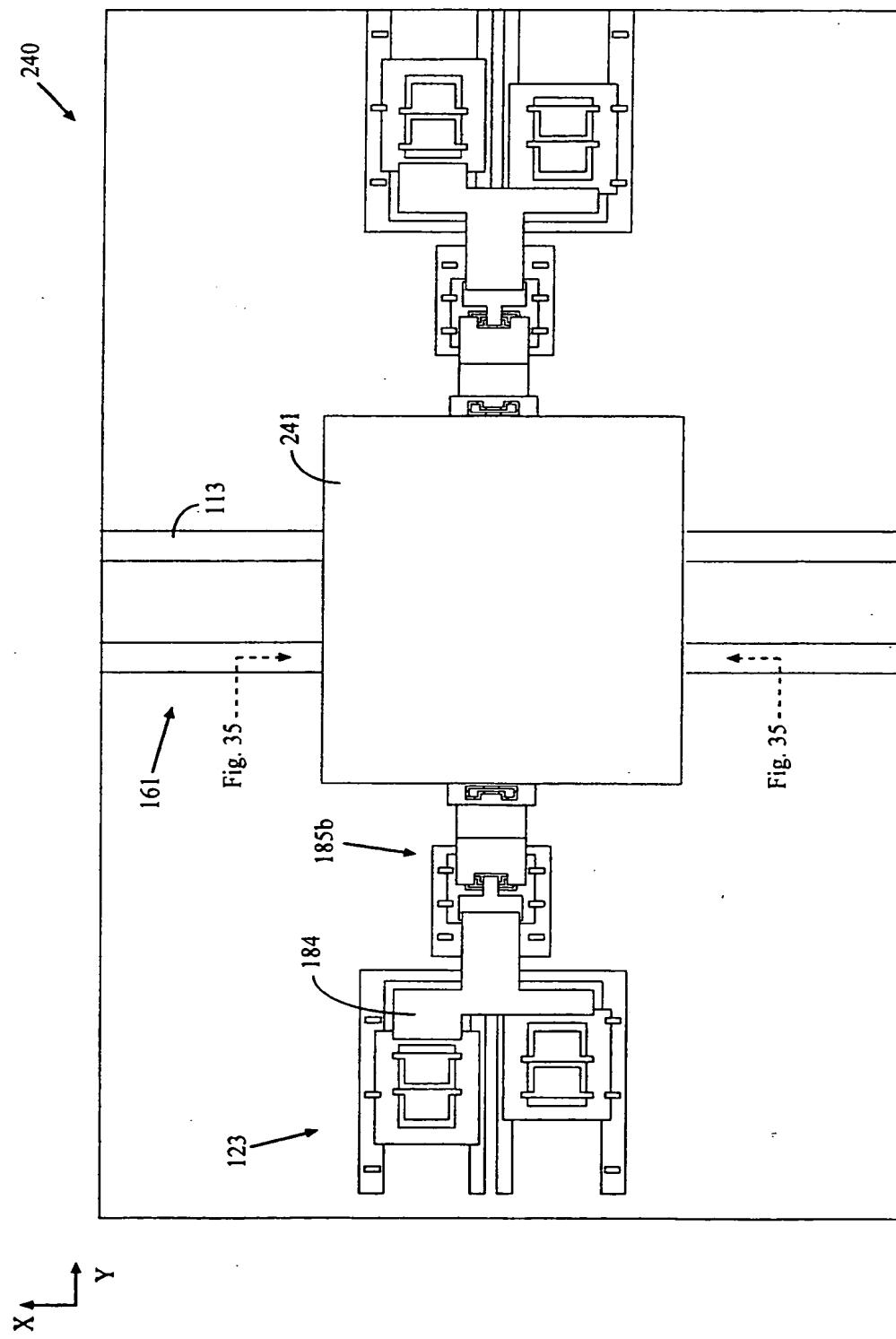


Fig. 33



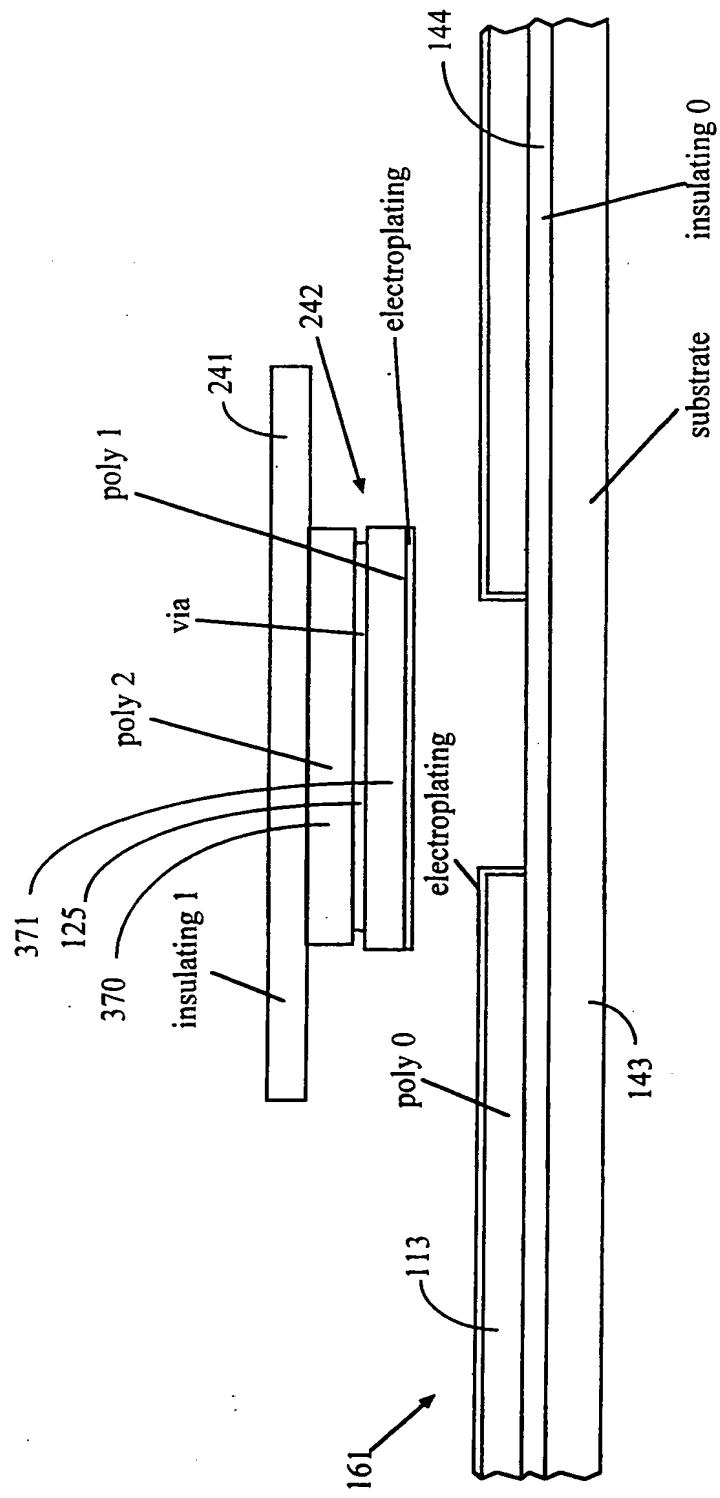


Fig. 35

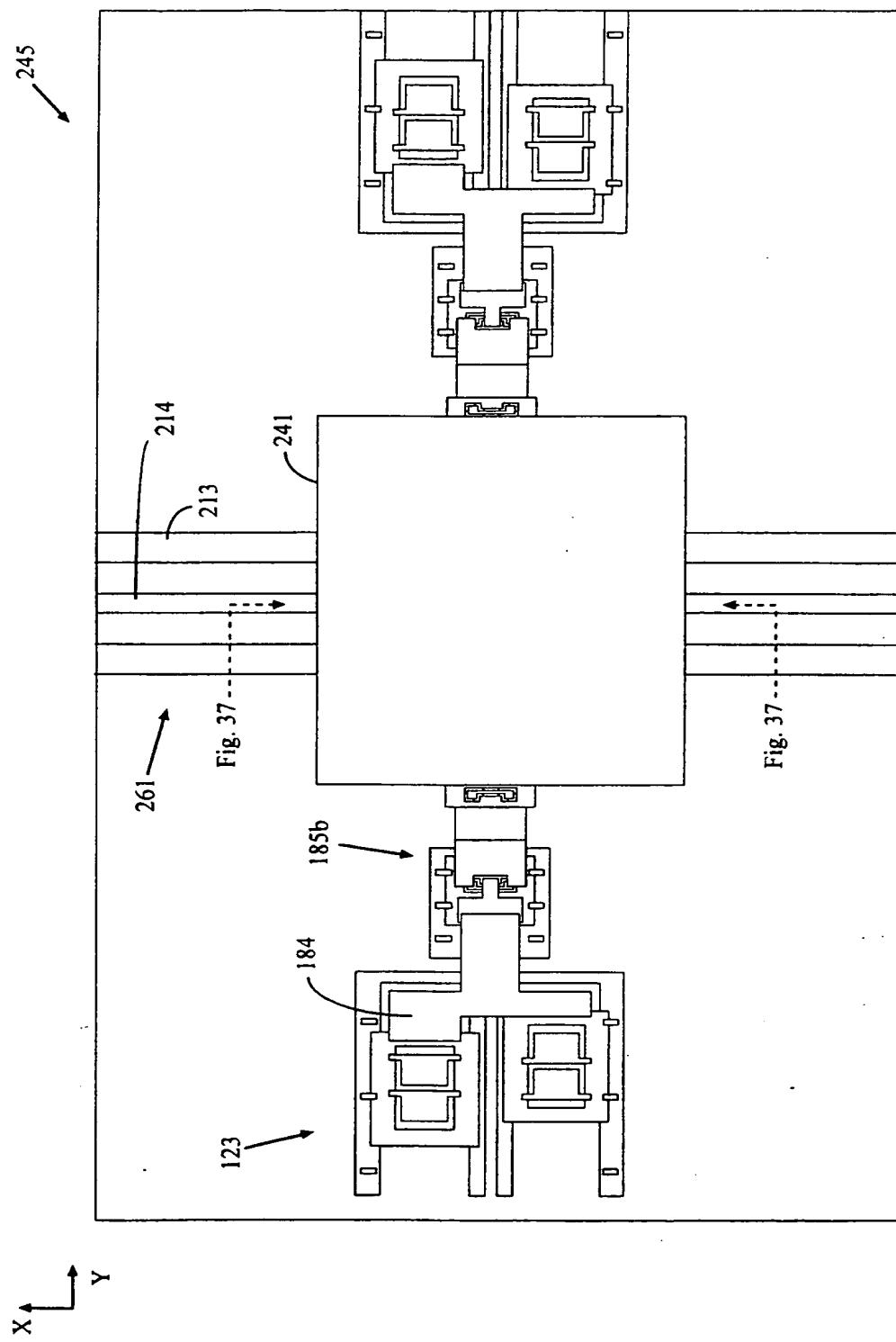


Fig. 36

10/009986

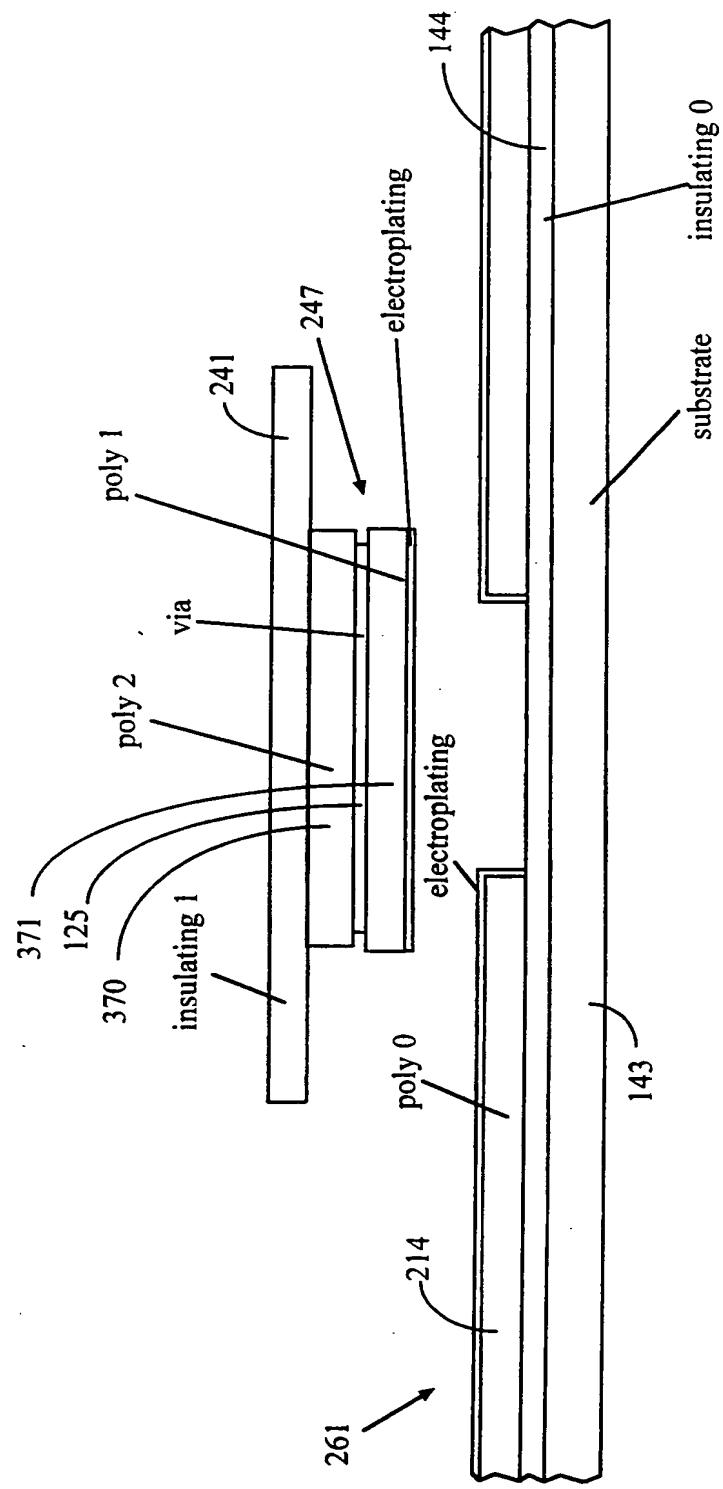


Fig. 37

10/009986

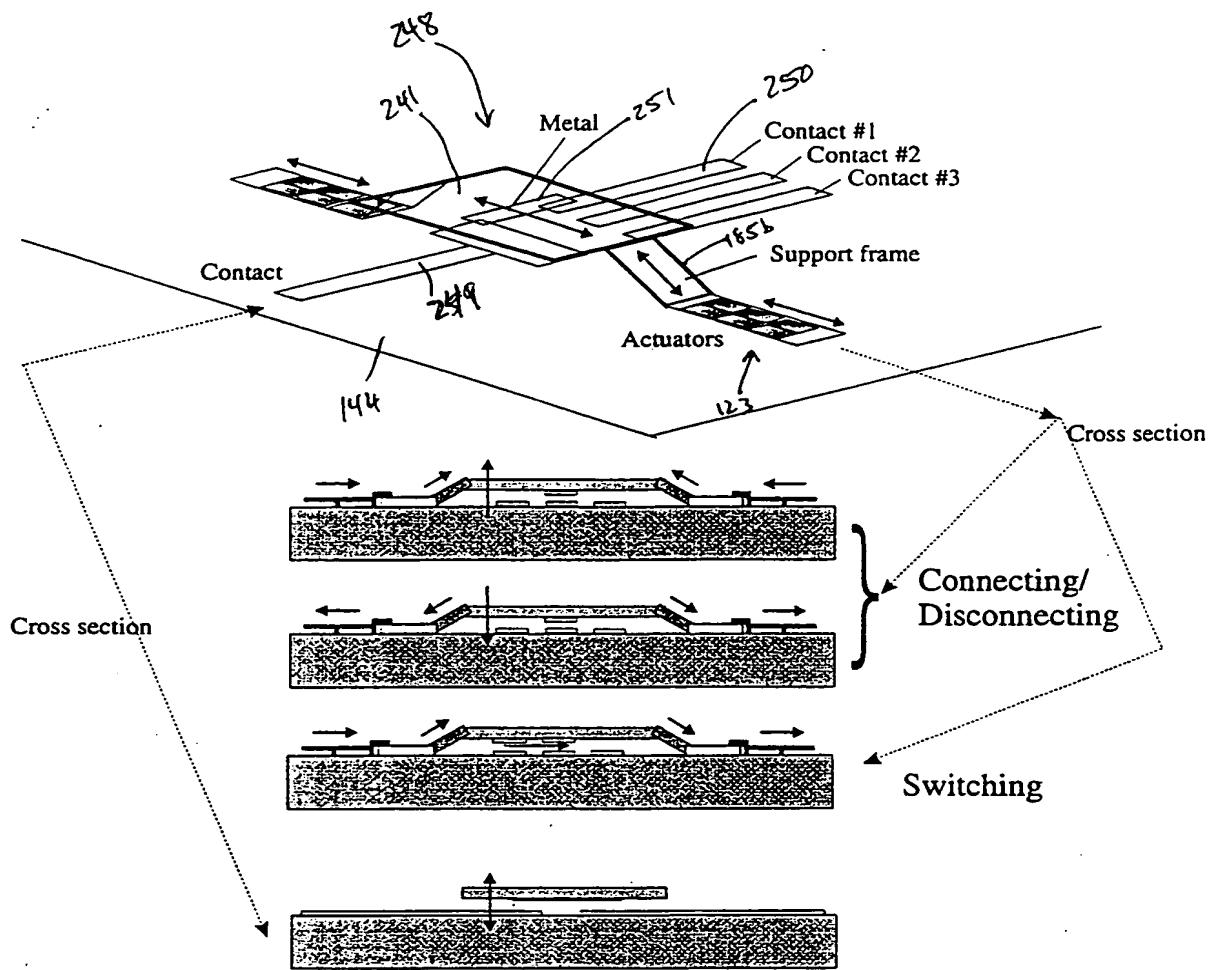


Figure 38a

10/009986

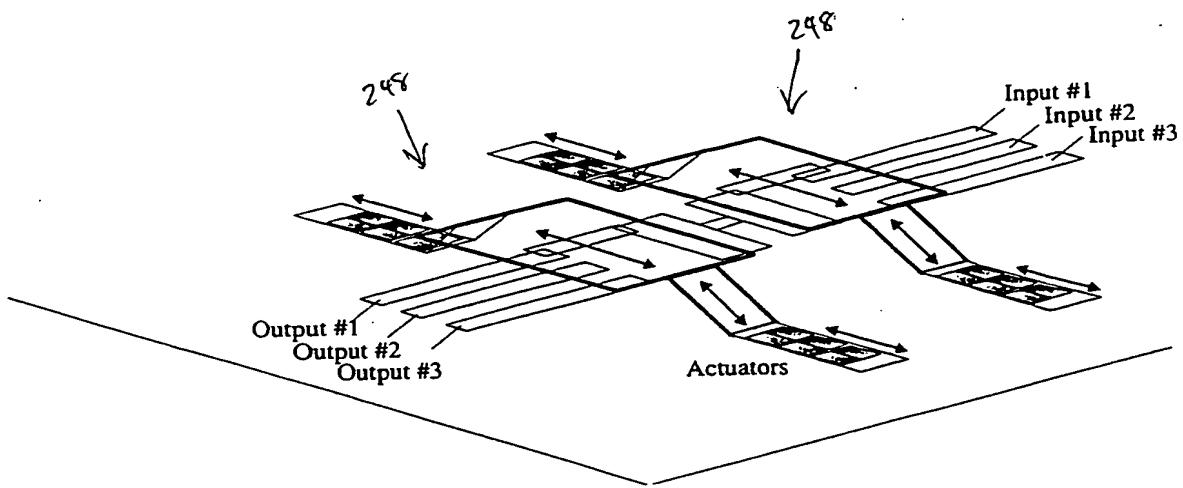


Figure 38b

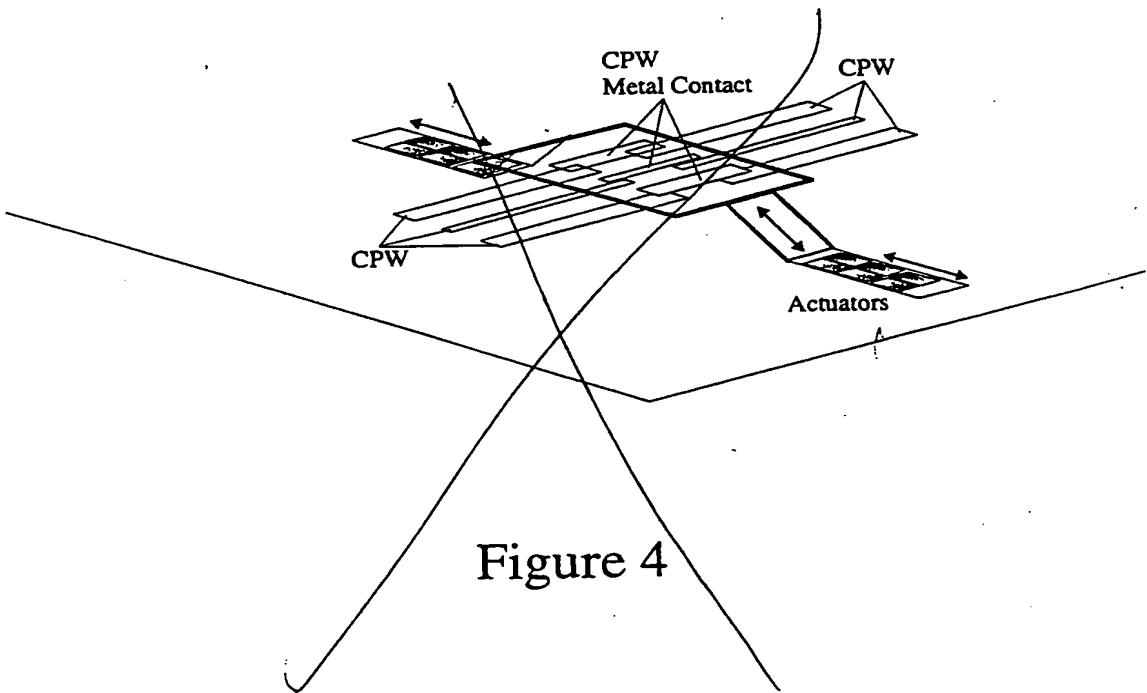
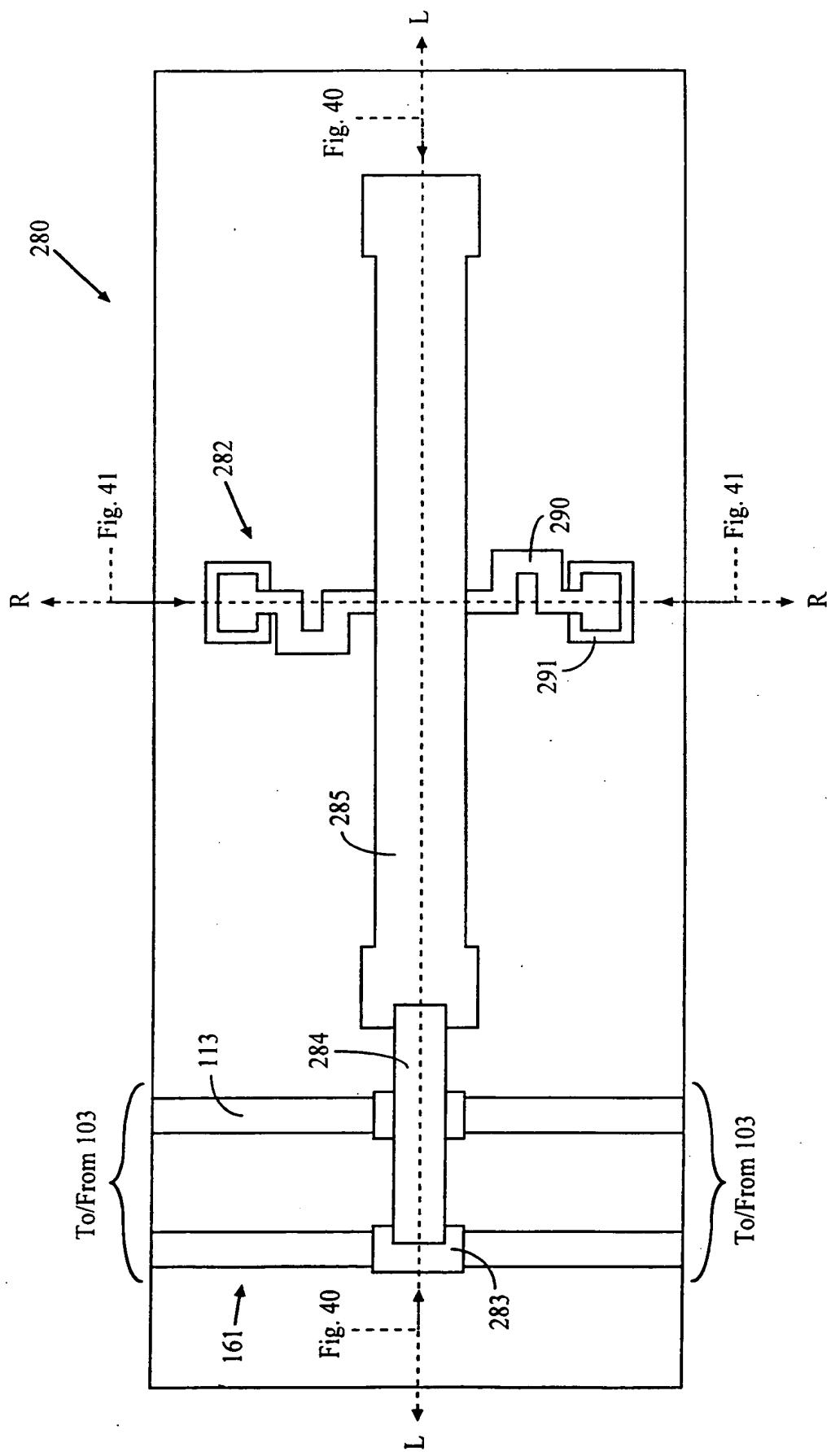


Figure 4

10/009986



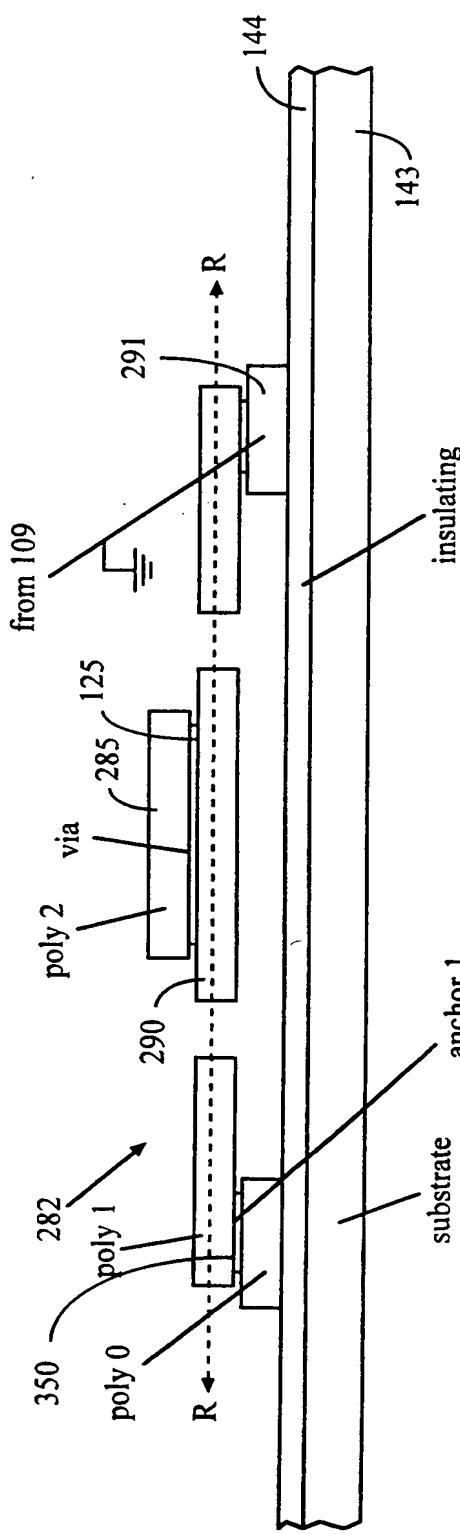


Fig. 41

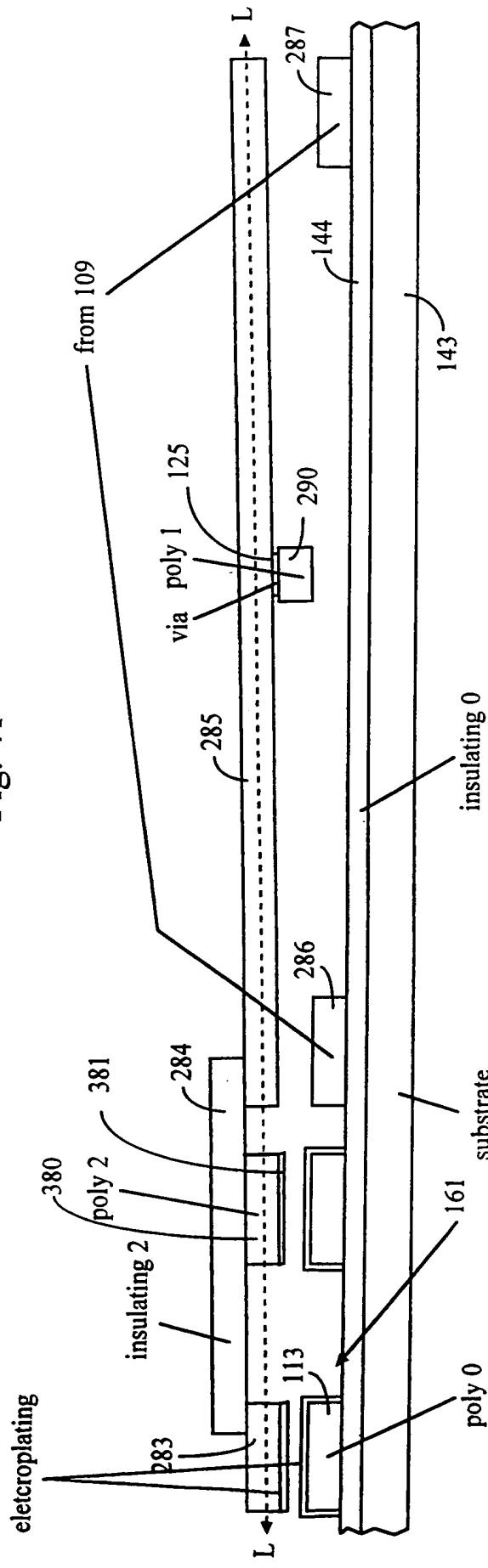
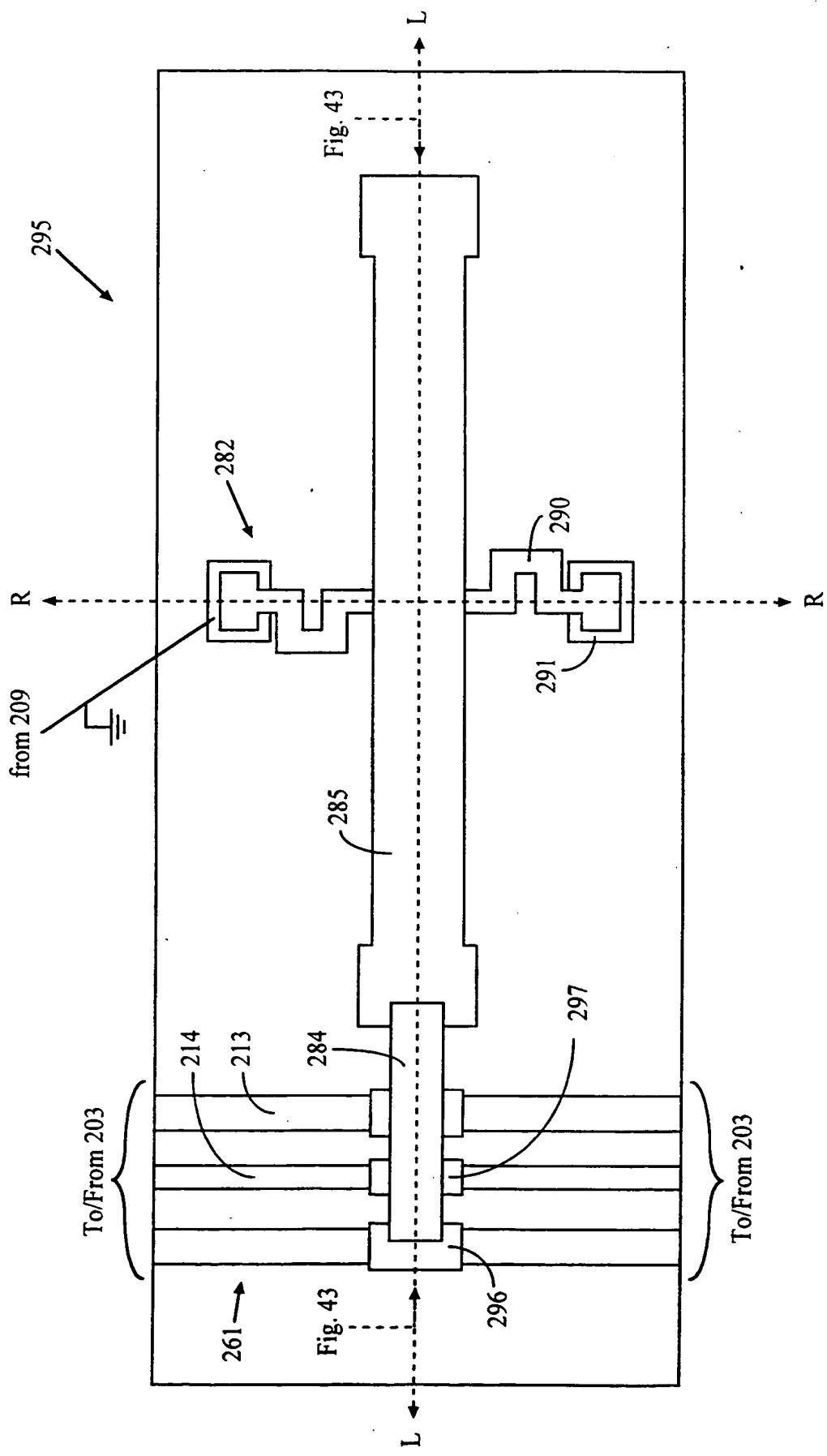


Fig. 40

10/009986



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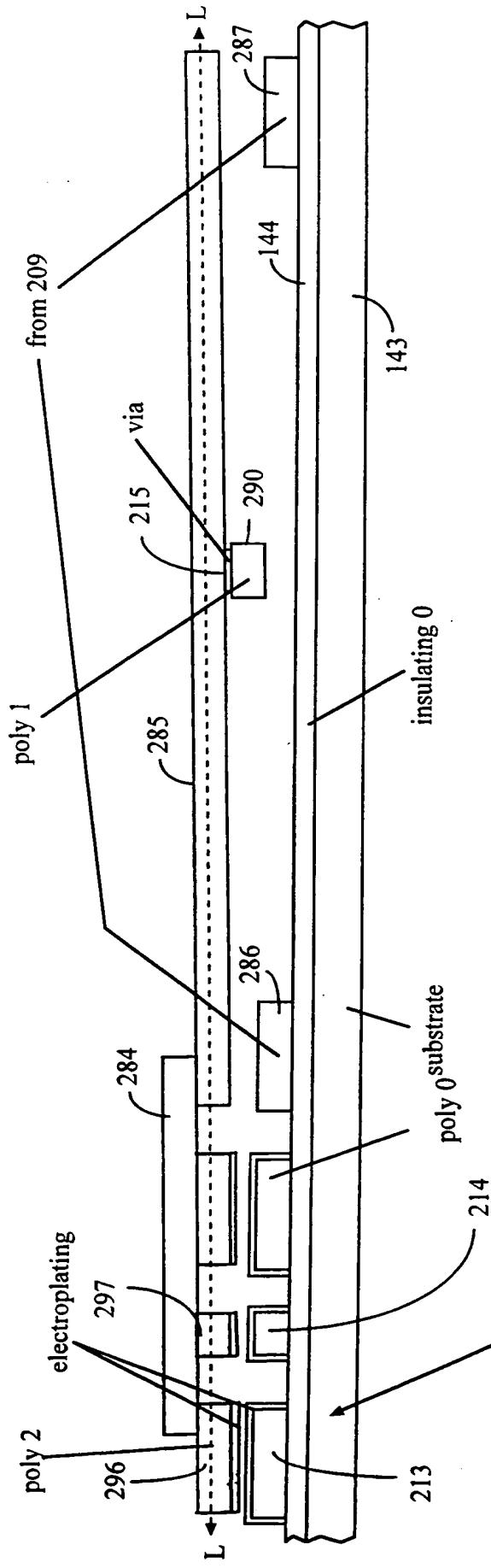


Fig. 43

10/009986

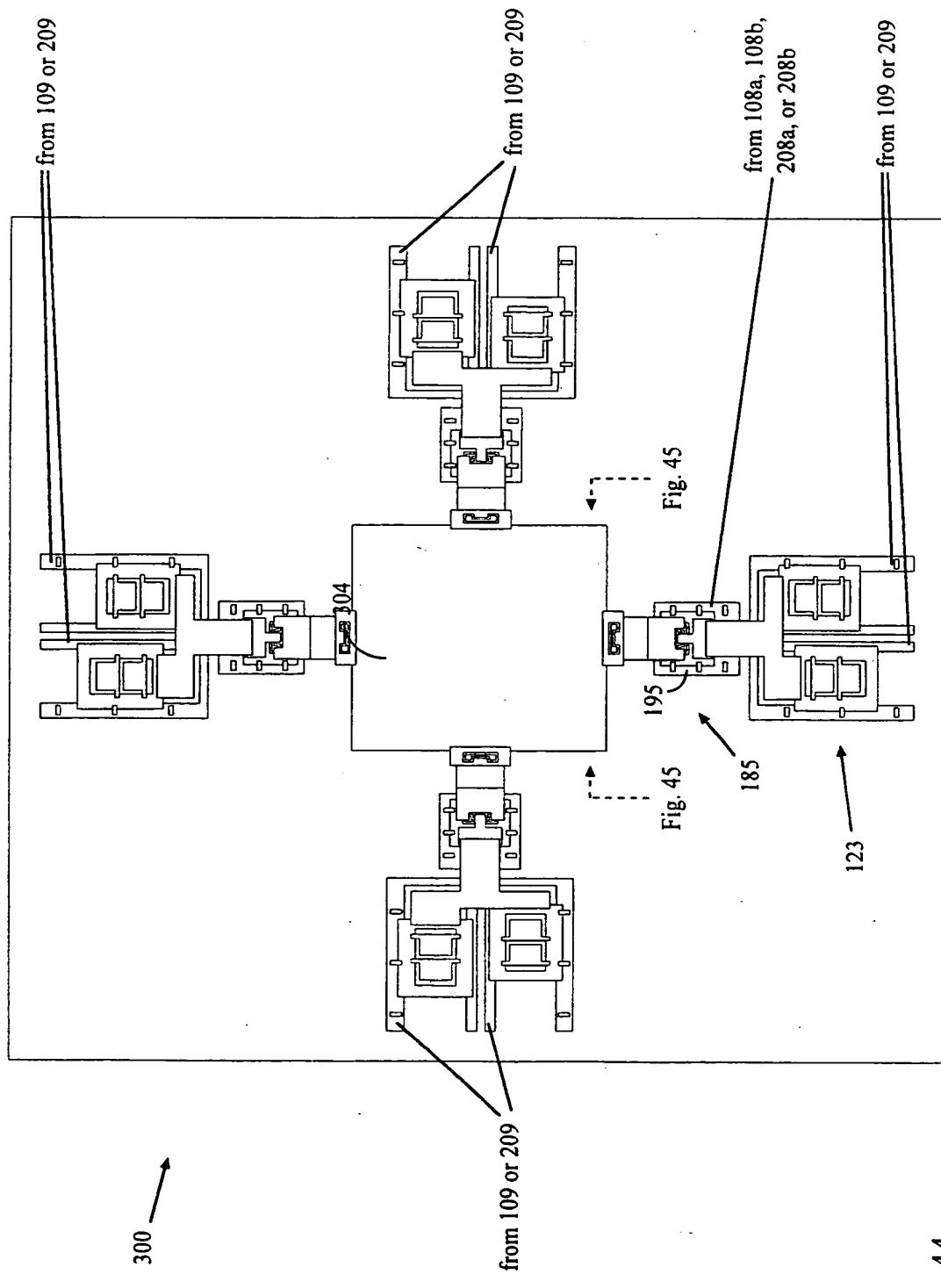


Fig. 44

10/009986

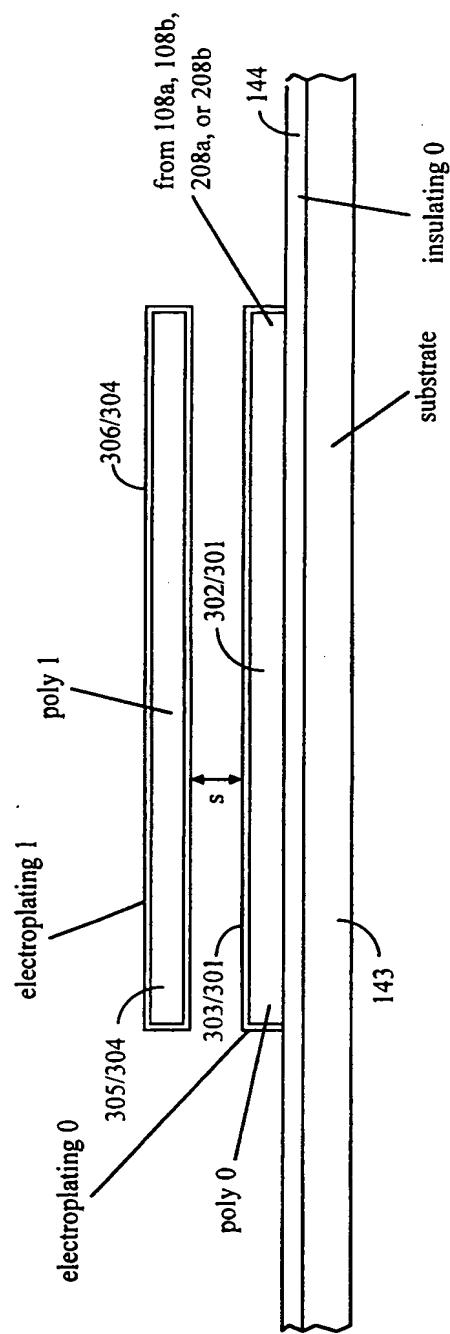


Fig. 45

10/009986

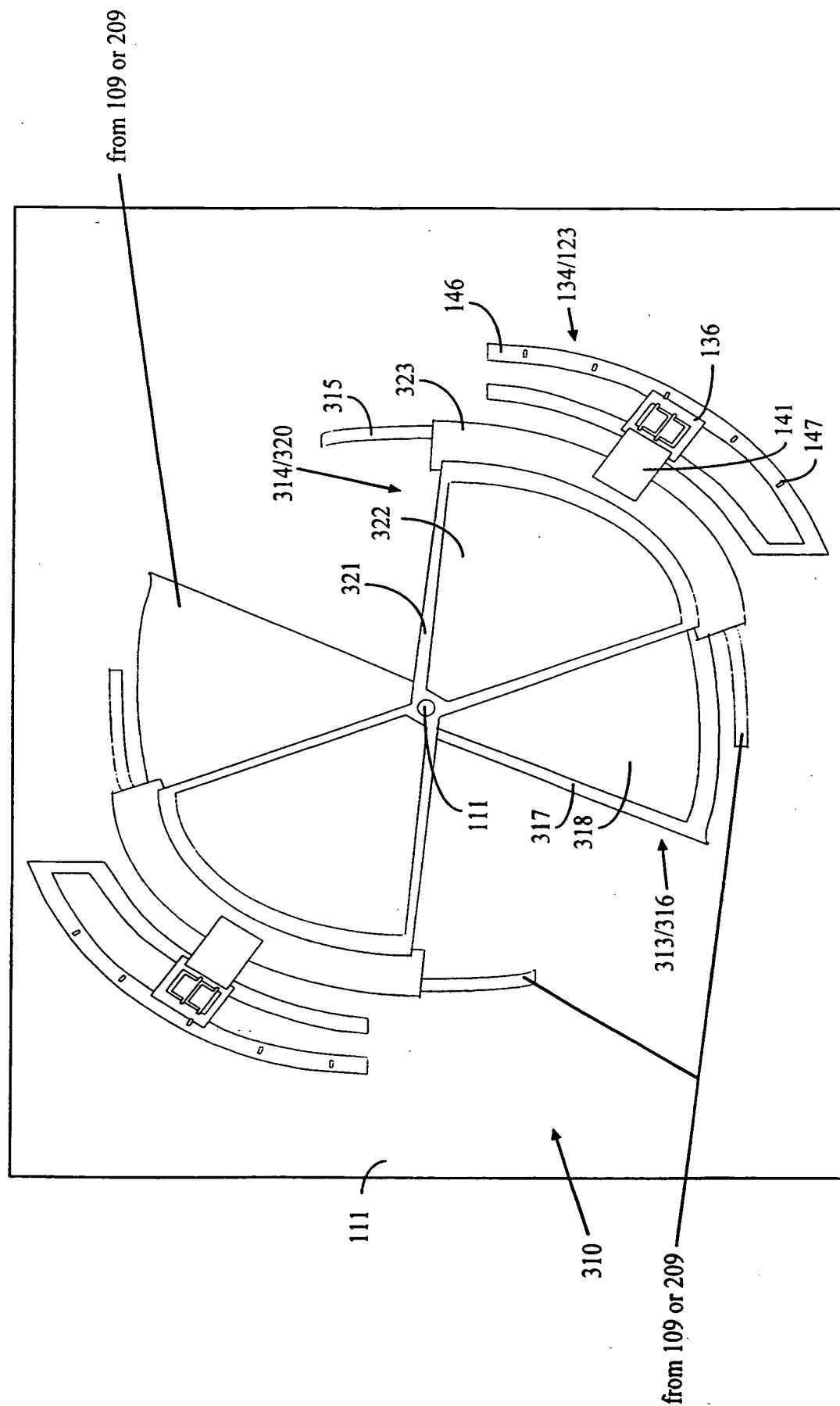


Fig. 46

10/009986

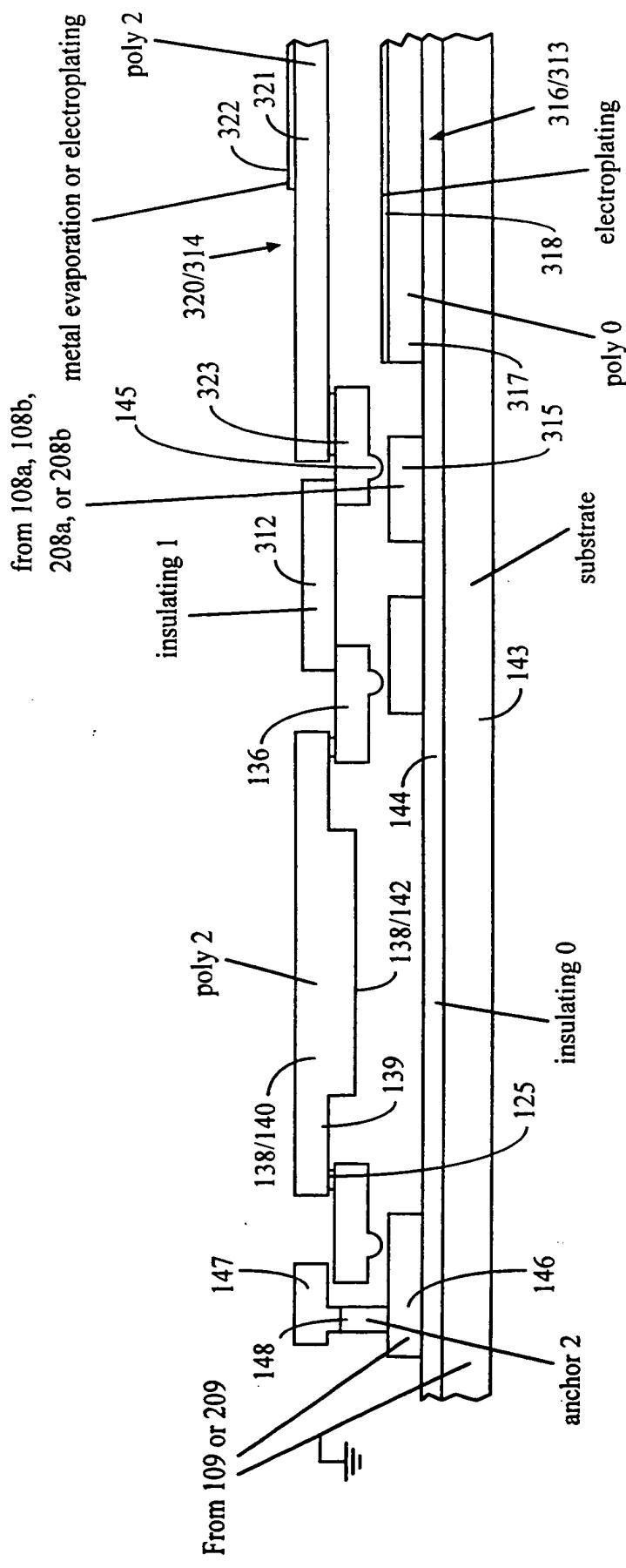


Fig. 47

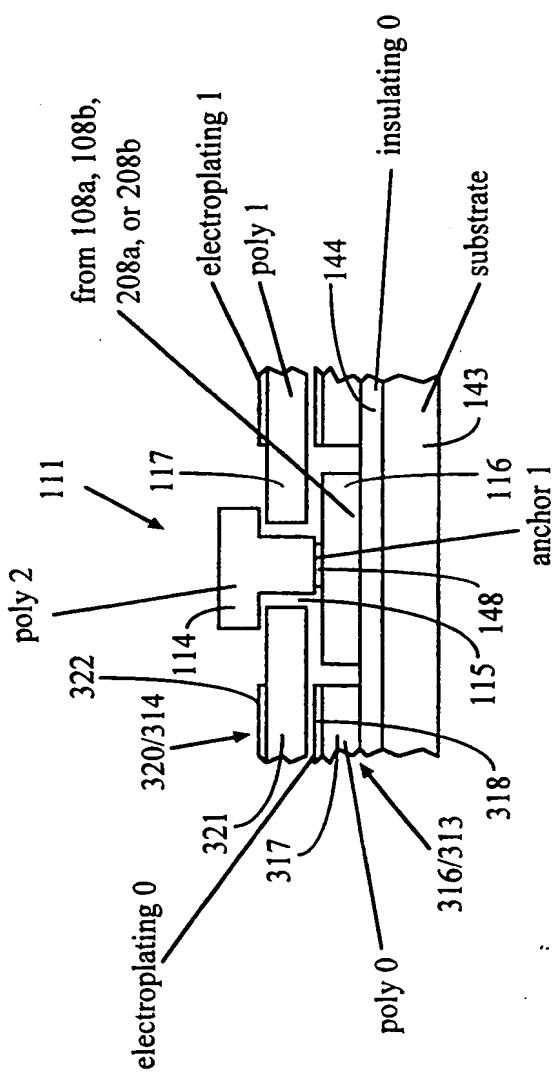
PCT/US00/16821
10/00/99 86

Fig. 48